

# **Datasheet**

Lyra 24P

Version 1.9



# **REVISION HISTORY**

Version	Date	Notes	Contributors	Approver
1.0	24 May 2023	Initial Release	Robert Gosewehr, Raj Khatri, Dave Drogowski	Jonathan Kaye
1.1	26 May 2023	Updated figure in section Lyra 24P USB Adaptor Label Marking	Raj Khatri	Jonathan Kaye
		Added Lyra 24P USB Adapter Environmental and Reliability Information		
1.2	15 June 2023	Table 26: Climatic and Dynamic Reliability Test Results for Lyra 24P USB Adapter	Connie Lin	Andrew Chen
		Table 28: MTBF Prediction for Lyra 24P USB Adapter		
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1.5	22 August 2023	Updated mechanical drawing in Dimensions for 450-00184 Lyra 24P – Bluetooth v5.4 USB Adaptor (20dBm) with Integrated Antenna (Silicon Labs EFR32BG24).	Dave Drogowski, Ivy Tseng	Jonathan Kaye
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### 1 Introduction

The Lyra 24P is a secure, high-performance wireless module optimized for the needs of battery and line powered IoT devices running on Bluetooth networks.

Based on the **Series 2 EFR32BG24 SoC**, it enables Bluetooth<sup>®</sup> Low Energy connectivity, delivering exceptional RF performance and energy efficiency, industry leading Secure Vault<sup>®</sup> technology, and future-proofing capabilities.

The Lyra 24P is a complete solution offered with robust and fully upgradeable software stacks, global regulatory certifications, advanced development and debugging tools, and documentation that simplifies and minimizes the development cycle of your end-product, helping to accelerate its time-to-market.

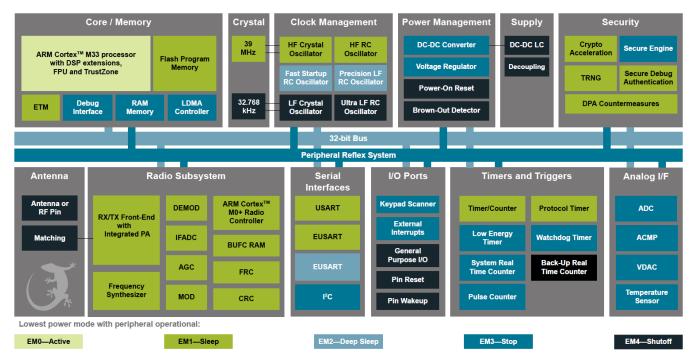
The Lyra 24P is intended for a broad range of applications, including:

- Smart Home Devices
- Lighting
- Building Automation and Security
- Gateways and Digital Assistants
- Bluetooth mesh Low Power Node

## 1.1 Key Features

- Bluetooth Low Energy 5.4
- Bluetooth Mesh connectivity
- Built-in antenna or RF pin
- +10 or +20 dBm TX output power (see 13.2, 13.3, and 13.5)
- -98.5 dBm BLE 1M RX sensitivity
- 32-bit ARM® Cortex®-M33 core at 39 MHz

- 1536/256 kB of Flash/RAM memory
- Vault High or Vault Mid security
- Rich set of analog and digital peripherals
- 26 GPIO pins
- -40 °C to 105 °C
- 12.9 mm x 15.0 mm





### 1.2 Hardware Features

### · Supported Protocols

- Bluetooth Low Energy (BLE) 5.4
- · Bluetooth Mesh

#### Wireless System-on-Chip

- · 2.4 GHz radio
- TX power up to +20 dBm (see 13.2, 13.3, and 13.5)
- 32-bit ARM Cortex®-M33 with DSP instruction and floating- point unit for efficient signal processing
- 1536 kB flash program memory 256 kB RAM data memory
- Embedded Trace Macrocell (ETM) for advanced debugging

#### · Receiver Sensitivity

- -106.5 dBm sensitivity (0.1% BER) at 125 kbps GFSK
- -102.2 dBm sensitivity (0.1% BER) at 500 kbps GFSK
- · -98.5 dBm sensitivity (0.1% BER) at 1 Mbps GFSK
- -95.7 dBm sensitivity (0.1% BER) at 2 Mbps GFSK

#### Current Consumption

- 4.5 mA RX current at 1 Mbps GFSK
- 4.8 mA TX current at 0 dBm (BGM240Px22)
- 18.8 mA TX current at 10 dBm (BGM240Px22)
- 154.8 mA TX current at 19.6 dBm (BGM240Px32)
- 33.4 µA/MHz in Active Mode (EM0) at 39.0 MHz
- 1.3 µA EM2 DeepSleep current (16 kB RAM retention and RTC running from LFRCO)

#### · Regulatory Certifications

- CE (EU)
- · UKCA (UK)
- FCC (USA)
- ISED (Canada)
- · MIC (Japan)
- · KC (South Korea)
- · AS/NZ (Australia, New Zealand)

#### · Operating Range

- 1.8 to 3.8 V
- -40 to +105°C

#### Dimensions

• 12.9 mm x 15.0 mm x 2.15 mm

#### Security

- · Secure Boot with Root of Trust and Secure Loader (RTSL)
- Hardware Cryptographic Acceleration with DPA countermeasures for AES128/256, SHA-1, SHA-2 (up to 256-bit), ECC (up to 256-bit), ECDSA, and ECDH
- True Random Number Generator (TRNG) compliant with NIST SP800-90 and AIS-31
- ARM® TrustZone®
- Secure Debug Interface lock/unlock Secure Key Management with PUF Anti-Tamper
- · Secure Attestation

#### MCU Peripherals

- · Analog to Digital Converter (ADC)
  - 12-bit @ 1 Msps
  - 16-bit @ 76.9 ksps
- 2 x Analog Comparator (ACMP)
- 2 x Digital to Analog Converter (VDAC)
- Up to 26 General Purpose I/O pins with output state retention and asynchronous interrupts
- · 8 Channel DMA Controller
- 16 Channel Peripheral Reflex System (PRS)
- 3 x 16-bit Timer/Counter with 3 Compare/Capture/PWM channels
- 2 x 32-bit Timer/Counter with 3 Compare/Capture/PWM channels
- 2 x 32-bit Real Time Counter (SYSRTC/BURTC)
- 24-bit Low Energy Timer for waveform generation (LETIM-ER)
- 16-bit Pulse Counter with asynchronous operation (PCNT)
   2 x Watchdog Timer (WDOG)
- 1 x Universal Synchronous/Asynchronous Receiver/Transmitter (USART), supporting UART/SPI/SmartCard (ISO 7816)/IrDA/I2S
- 2 x Enhanced Universal Synchronous/Asynchronous Receiver/Transmitter (EUSART) supporting UART/SPI/DALI/ IrDA
- 2 x I2C interface with SMBus support
- Low-Frequency RC Oscillator with precision mode to replace 32 kHz sleep crystal (LFRCO)
- Keypad scanner supporting up to 6x8 matrix (KEYSCAN)
- Die temperature sensor with ±1.5°C accuracy after single point calibration



# 1.3 Firmware Options

The Lyra 24P series supports two different firmware options for software development:

**AT Command Set** – fully featured and extensible to suit any developer's needs.

- Proven over 5+ years
- Basic Bluetooth LE cable replacement
- Simplest implementation possible

**C Code** – Full software development with Silicon Labs SDK and Toolchain

- Native C code development
- Use Simplicity Studio IDE
- Full functionality of Silicon Labs HW / SW

## 2 Ordering Information

Table 1: Ordering Information

Part	Description
453-00142R	Lyra 24P Series - Bluetooth v5.4 PCB Module (10dBm) with integrated antenna (Silicon Labs EFR32BG24) - Tape / Reel
453-00142C	Lyra 24P Series - Bluetooth v5.4 PCB Module (10dBm) with integrated antenna (Silicon Labs EFR32BG24) - Cut / Tape
453-00145R	Lyra 24P Series - Bluetooth v5.4 PCB Module (20dBm) with integrated antenna (Silicon Labs EFR32BG24) - Tape / Reel
453-00145C	Lyra 24P Series - Bluetooth v5.4 PCB Module (20dBm) with integrated antenna (Silicon Labs EFR32BG24) - Cut / Tape
453-00148R	Lyra 24P Series - Bluetooth v5.4 PCB Module (20dBm) with RF Trace Pad (Silicon Labs EFR32BG24) - Tape / Reel
453-00148C	Lyra 24P Series - Bluetooth v5.4 PCB Module (20dBm) with RF Trace Pad (Silicon Labs EFR32BG24) - Cut / Tape
453-00142-K1	Lyra 24P Series - Development Kit - Bluetooth v5.4 PCB Module (10dBm) with integrated antenna
453-00145-K1	Lyra 24P Series - Development Kit - Bluetooth v5.4 PCB Module (20dBm) with integrated antenna
453-00148-K1	Lyra 24P Series - Development Kit - Bluetooth v5.4 PCB Module (20dBm) with RF Trace Pad
450-00184	Lyra 24P Series - Bluetooth v5.4 USB Adapter (20dBm) with integrated antenna (Silicon Labs EFR32BG24)

#### Note:

- 1. Lyra 24P series modules operate in the 2.4 GHz ISM frequency band.
- 2. The maximum RF TX power allowed by different regional regulatory authorities may differ from the maximum output power a module can produce. End-product manufacturers must then verify that the module is configured to meet the regulatory limits for each region in accordance with the local rules and the formal certification test reports.
- 3. See section 13.2, 13.3, and 13.5 per Lyra 24P module part number.
- 4. Lyra 24P modules are pre-programmed with Lyra 24P BGAPI UART/OTA DFU bootloader. Lyra 24P AT firmware can be loaded by the customer (via SWD interface or via boot loader (UART or OTA)). Lyra 24P USB dongle ships with bootloader and AT firmware.



# **3 SYSTEM OVERVIEW**

# 3.1 Block Diagram

The Lyra 24P module is a highly-integrated, high-performance system with all the hardware components needed to enable 2.4 GHz wireless connectivity and support robust networking capabilities via multiple wireless protocols.

Built around the **EFR32BG24** Wireless SoC, the Lyra 24P includes a built-in antenna, an RF matching network (optimized for transmit power efficiency), supply decoupling and filtering components, an LC tank for DC-DC conversion, a 39 MHz reference crystal, and an RF shield. Also, it supports the use of an external 32 kHz crystal as a low frequency reference signal via GPIO pins for use cases demanding maximum energy efficiency.

For designs where an external antenna solution may be beneficial, a module variant with a 50  $\Omega$ -matched RF pin instead of the built-in antenna is available (for Lyra 24P, RF, 20dBm, RF Trace only).

Because the RF matching network is optimized for transmit power efficiency, modules rated for +20 dBm will show non-optimal current consumption and performance when operated at a lower output power (i.e. +10 or 0 dBm).

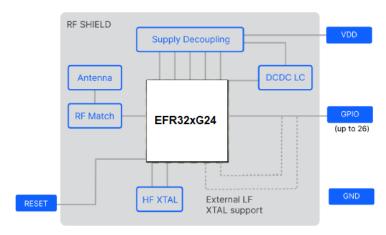


Figure 3: Lyra 24P Block Diagram - Built-in Antenna Variant

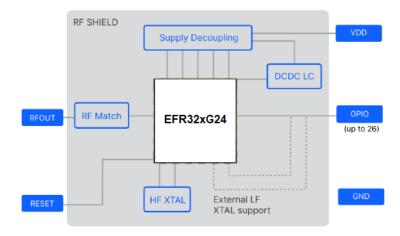


Figure 4: Lyra 24P Block Diagram – RF Pin Variant



A simplified internal schematic for the Lyra 24P module is shown in Figure 5.

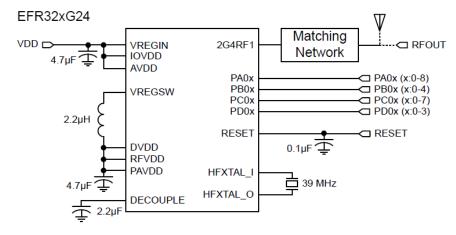


Figure 5: Lyra 24P Module Schematic

## 3.2 EFR32BG24 SoC

The **EFR32BG24** SoC features a 32-bit ARM Cortex M33 core, a 2.4 GHz high-performance radio, 1536 kB of Flash memory, 256 kB of RAM, a dedicated core for security, a rich set of MCU peripherals, and various clock management and serial interfacing options. See the EFR32xG24 Reference Manual and EFR32BG24 Data Sheet for details.

## 3.3 Integrated Antenna

Lyra 24P modules come with two antenna solutions variants: A built-in antenna or a 50 Ohms matched RF pin to support an external antenna. Typical performance characteristics of the built-in antenna are detailed in table below.

Table 2: Integrated Antenna Efficiency and Peak Gain

Parameter	With optimal layout	Note
Efficiency	-1 dB	Antenna efficiency, gain, and radiation pattern are highly dependent on the application PCB layout and mechanical design. Refer to Design Guidelines for recommendations to achieve
Peak gain	1.82 dBi	optimal antenna performance.

## 3.4 External Antenna

Lyra 24P module can be used with external antennas (certified by Laird Connectivity) and requires a RF 50 Ohm track (Ground Coplanar Waveguide) to be designed to run from Lyra 24P module RFOUT (pin 33) to an RF antenna connector (IPEX MHF 4) on the host PCB. The 50 ohm RF track design and length **MUST** be copied as defined in section Lyra 24P Module 50 Ohms RF Track Design for Connecting External Antenna with the Lyra 24P Module, 20dBm, RF Pad Variant (453-00148).

The list of supported external antennas (certified by Laird Connectivity) are listed in section External Antenna Integration with the Lyra 24P Module.



## 3.5 Power Supply

The Lyra 24P requires a single nominal supply level (VDD) to operate and supports an operating range of 1.8 to 3.8 V. The nominal level needed for **+10 dBm devices** (part number: 453-00142) **is 3.0 V** whereas **+20 dBm devices** (part number: 453-00145 and 453-00148) **require 3.3 V** in order to achieve higher TX output power. All necessary decoupling, filtering and DC-DC-related components are included in the module.

Note:

The power amplifier for +10 dBm modules is supplied through an internal LDO, and thus is independent of the VDD supply. Respectively, the power amplifier for +20 dBm modules is supplied through the VDD pin with a target level of 3.3 V.

## 3.6 General Purpose Input / Output (GPIO)

The Lyra 24P has up to 26 General Purpose Input/Output pins. Each GPIO pin can be individually configured as either an output or input. More advanced configurations including open-drain, open-source, and glitch-filtering can be configured for each individual GPIO pin. The GPIO pins can be overridden by peripheral connections, like SPI communication. Each peripheral connection can be routed to several GPIO pins on the device. The input value of a GPIO pin can be routed through the Peripheral Reflex System to other peripherals. The GPIO subsystem supports asynchronous external pin interrupts.

All of the pins on ports A and port B are EM2 capable. These pins may be used by Low-Energy peripherals in EM2/3 and may also be used as EM2/3 pin wake-ups. Pins on ports C and D are latched/retained in their current state when entering EM2 until EM2 exit upon which internal peripherals could once again drive those pads.

A few GPIOs also have EM4 wake functionality. These pins are listed in Table 19: GPIO Alternate Function Table.

## 3.7 Security

Lyra 24P modules support one of two levels in the Security Portfolio offered by Silicon Labs: **Secure Vault Mid** or **Secure Vault High**. Lyra 24P modules support Secure Vault High.

Secure Vault is a collection of technologies that deliver state-of-the-art security and upgradability features to protect and futureproof IoT devices against costly threats, attacks, and tampering. A dedicated security CPU enables the Secure Vault functions and isolates cryptographic functions and data from the Cortex-M33 core. Lyra 24P part numbers support Secure Vault High.

Table 3: Secure Vault Features

Feature	Secure Vault Mid	Secure Vault High
True Random Number Generator (TRNG)	Yes	Yes
Secure Boot with Root of Trust and Secure Loader (RTSL)	Yes	Yes
Secure Debug with Lock/Unlock	Yes	Yes
DPA Countermeasures	Yes	Yes
Anti-Tamper		Yes
Secure Attestation		Yes
Secure Key Management		Yes
Symmetric Encryption	<ul> <li>AES 128 / 192 / 256 bit</li> <li>ECB, CTR, CBC, CFB, CCM, GCM, CBC-MAC, and GMAC</li> </ul>	<ul> <li>AES 128 / 192 / 256 bit</li> <li>ECB, CTR, CBC, CFB, CCM, GCM, CBC-MAC, and GMAC</li> <li>ChaCha20</li> </ul>
Public Key Encryption - ECDSA / ECDH / EdDSA	• p192 and p256	<ul><li>p192, p256, p384 and p521</li><li>Curve25519 (ECDH)</li><li>Ed25519 (EdDSA)</li></ul>



Feature	Secure Vault Mid	Secure Vault High
Key Derivation	ECJ-PAKE p192 and p256	<ul><li>ECJ-PAKE p192, p256, p384, and p521</li><li>PBKDF2</li><li>HKDF</li></ul>
Hashes	<ul><li>SHA-1</li><li>SHA-2/256</li></ul>	<ul><li>SHA-1</li><li>SHA-2 256, 384, and 512</li><li>Poly1305</li></ul>

## 3.7.1 Secure Boot with Root of Trust and Secure Loader (RTSL)

The Secure Boot with RTSL authenticates a chain of trusted firmware that begins from an immutable memory (ROM).

It prevents malware injection, prevents rollback, ensures that only authentic firmware is executed, and protects Over The Air updates. For more information about this feature, see AN1218: Series 2 Secure Boot with RTSL.

## 3.7.2 Cryptographic Accelerator

The Cryptographic Accelerator is an autonomous hardware accelerator with Differential Power Analysis (DPA) countermeasures to protect keys.

It supports AES encryption and decryption with 128/192/256-bit keys, ChaCha20 encryption, and Elliptic Curve Cryptography (ECC) to support public key operations, and hashes.

Supported block cipher modes of operation for AES include:

- ECB (Electronic Code Book)
- CTR (Counter Mode)
- CBC (Cipher Block Chaining)
- CFB (Cipher Feedback)
- GCM (Galois Counter Mode)
- CCM (Counter with CBC-MAC)
- CBC-MAC (Cipher Block Chaining Message Authentication Code)
- GMAC (Galois Message Authentication Code)

The Cryptographic Accelerator accelerates Elliptical Curve Cryptography and supports the NIST (National Institute of Standards and Technology) recommended curves including P-192, P-256, P-384, and P-521 for ECDH (Elliptic Curve Diffie-Hellman) key derivation, and ECDSA (Elliptic Curve Digital Signature Algorithm) sign and verify operations. Also supported is the non-NIST Curve25519 for ECDH and Ed25519 for EdDSA (Edwards-curve Digital Signature Algorithm) sign and verify operations.

Secure Vault also supports ECJ-PAKE (Elliptic Curve variant of Password Authenticated Key Exchange by Juggling) and PBKDF2 (Password-Based Key Derivation Function 2).

Supported hashes include SHA-1, SHA-2/256/384/512 and Poly1305.

This implementation provides a fast and energy efficient solution to state of the art cryptographic needs.

#### 3.7.3 True Random Number Generator

The True Random Number Generator module is a non-deterministic random number generator that harvests entropy from a thermal energy source. It includes start-up health tests for the entropy source as required by NIST SP800-90B and AIS-31 as well as online health tests required for NIST SP800-90C.

The **TRNG** is suitable for periodically generating entropy to seed an approved pseudo random number generator.

#### 3.7.4 Secure Debug with Lock / Unlock

For obvious security reasons, it is critical for a product to have its debug interface locked before being released in the field.

In addition, Secure Vault High also provides a secure debug unlock function that allows authenticated access based on public key cryptography. This functionality is particularly useful for supporting failure analysis while maintaining confidentiality of IP and sensitive end- user data.



For more information about this feature, see AN1190: Series 2 Secure Debug.

#### 3.7.5 DPA Countermeasures

The AES and ECC accelerators have Differential Power Analysis (DPA) countermeasures support. This makes it very expensive from a time and effort standpoint to use DPA to recover secret keys.

## 3.7.6 Secure Key Management with PUF

Key material in Secure Vault High products is protected by "key wrapping" with a standardized symmetric encryption mechanism. This method has the advantage of protecting a virtually unlimited number of keys, limited only by the storage that is accessible by the Cortex-M33, which includes off-chip storage as well. The symmetric key used for this wrapping and unwrapping must be highly secure because it can expose all other key materials in the system. The Secure Vault Key Management system uses a Physically Unclonable Function (PUF) to generate a persistent device-unique seed key on power up to dynamically generate this critical wrapping/unwrapping key which is only visible to the AES encryption engine and is not retained when the device loses power.

## 3.7.7 Anti-Tamper

Secure Vault High devices provide internal tamper protection which monitors parameters such as voltage, temperature, and electromagnetic pulses as well as detecting tamper of the security sub-system itself. Additionally, eight external configurable tamper pins support external tamper sources, such as enclosure tamper switches.

For each tamper event, the user is able to select the severity of the tamper response ranging from an interrupt, to a reset, to destroying the PUF reconstruction data which will make all protected key materials un-recoverable and effectively render the device inoperable. The tamper system also has an internal resettable event counter with programmable trigger threshold and refresh periods to mitigate false positive tamper events.

For more information about this feature, see AN1247: Anti-Tamper Protection Configuration and Use.

#### 3.7.8 Secure Attestation

Secure Vault High products support Secure Attestation, which begins with a secure identity that is created during the Silicon Labs manufacturing process. During device production, each device generates its own public/private keypair and securely stores the wrapped private key into immutable OTP memory and this key never leaves the device. The corresponding public key is extracted from the device and inserted into a binary DER-encoded X.509 device certificate, which is signed into a Silicon Labs CA chain and then programmed back into the chip into an immutable OTP memory.

The secure identity can be used to authenticate the chip at any time in the life of the product. The production certification chain can be requested remotely from the product. This certification chain can be used to verify that the device was authentically produced by Silicon Labs. The device unique public key is also bound to the device certificate in the certification chain. A challenge can be sent to the chip at any point in time to be signed by the device private key. The public key in the device certificate can then be used to verify the challenge response, proving that the device has access to the securely-stored private key, which prevents counterfeit products or impersonation attacks.

For more information about this feature, see AN1268: Authenticating Silicon Labs Devices Using Device Certificates.

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## 4 ELECTRICAL CHARACTERISTICS

All electrical parameters in all tables are specified under the following conditions, unless stated otherwise:

- Typical values are based on T<sub>A</sub>=25 °C and VDD supply at 3.0 V, by production test and/or technology characterization.
- Radio performance numbers are measured in conducted mode, based on Silicon Laboratories reference designs using output power-specific external RF impedance-matching networks for interfacing to a 50 Ω antenna.
- Minimum and maximum values represent the worst conditions across supply voltage, process variation, and operating temperature, unless stated otherwise.

# 4.1 Absolute Maximum Ratings

Table 4: Absolute Maximum Ratings

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Storage temperature range	T <sub>STG</sub>		-40	_	+105	°C
Voltage on VDD supply pin	$V_{DDMAX}$		-0.3	_	3.8	V
Voltage ramp rate on VDD supply pin	V <sub>DDRAMPMAX</sub>		_	_	1.0	V/µs
DC voltage on any GPIO pin	$V_{DIGPIN}$		-0.3	_	V <sub>VDD</sub> +0.3	V
DC voltage on RESETn pin <sup>1</sup>	V <sub>RESETn</sub>		-0.3	_	3.8	V
Absolute voltage on RFOUT pin	$V_{MAX2G4}$		-0.3	_	V <sub>VDD</sub> +0.3	V
Total current into VDD pin	$I_{VDDMAX}$	Source	_	_	200	mA
Total current into GND pin	$I_{GNDMAX}$	Sink	_	_	200	mA
Current per I/O pin	I <sub>IOMAX</sub>	Sink	_	_	50	mA
		Source	_	_	50	mA
Current for all I/O pins	I <sub>IOALLMAX</sub>	Sink —		_	200	mA
		Source	_	_	200	mA

### Note:

<sup>1.</sup> The RESETn pin has a pull-up device to the internal DVDD supply. For minimum leakage, RESETn should not exceed the voltage at DVDD, which is generated by the DC-DC converter. DVDD is equal to 1.8 V when DC-DC is active and bypassed to VDD when DC-DC is inactive.



# 4.2 General Operating Conditions

# Table 5: General Operating Conditions

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Operating ambient temperature range	T <sub>A</sub>		-40	_	+105	°C
VDD operating supply voltage	$V_{VDD}$	10 dBm Module, DC-DC in regulation	2.2	3.0	3.8	V
		20 dBm Module, DC-DC in regulation	2.2	3.3	3.8	V
		10 dBm Module, DC-DC in bypass	1.8	3.0	3.8	V
		20 dBm Module, DC-DC in bypass	1.8	3.3	3.8	V
HCLK and SYSCLK frequency	f <sub>HCLK</sub>	VSCALE2, MODE = WS1	_	_	78	MHz
		VSCALE2, MODE = WS0	_	_	40	MHz
PCLK frequency	f <sub>PCLK</sub>	VSCALE2 or VSCALE1	_	_	40	MHz
EM01 Group A clock frequency	f <sub>EM01GRPACLK</sub>	VSCALE2	_	_	78	MHz
		VSCALE1	_	_	40	MHz
EM01 Group C clock frequency	f <sub>EM01GRPBCLK</sub>	VSCALE2	_	_	78	MHz
		VSCALE1	_	_	40	MHz
Radio HCLK frequency	f <sub>RHCLK</sub>	VSCALE2 or VSCALE1	_	39.0	_	MHz



# 4.3 MCU Current Consumption with 3 V Supply

Unless otherwise indicated, typical conditions are: VDD = 3.0 V, DC-DC in regulation. Voltage scaling level = VSCALE1.  $T_A$  = 25 °C. Minimum and maximum values in this table represent the worst conditions across process variation at  $T_A$  = 25 °C.

Table 6: MCU Current Consumption with 3 V Supply

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Current consumption in EM0 mode with all peripherals disabled	I <sub>ACTIVE</sub>	78 MHz HFRCO w/ DPLL referenced to 39 MHz crystal, CPU running Prime from flash, VSCALE2	_	33.3	_	μΑ/MHz
		78 MHz HFRCO w/ DPLL referenced to 39 MHz crystal, CPU running while loop from flash, VSCALE2	_	32.8	_	µA/MHz
		78 MHz HFRCO w/ DPLL referenced to 39 MHz crystal, CPU running CoreMark loop from flash, VSCALE2	_	49.1	_	μΑ/MHz
		39 MHz crystal, CPU running Prime from flash	_	33.9	_	µA/MHz
		39 MHz crystal, CPU running while loop from flash	_	33.4	_	μΑ/MHz
		39 MHz crystal, CPU running CoreMark loop from flash	_	49.4	_	μΑ/MHz
		38 MHz HFRCO, CPU running while loop from flash	_	28.1	_	µA/MHz
Current consumption in EM1 mode with all	I <sub>EM1</sub>	78 MHz HFRCO w/ DPLL referenced to 39 MHz crystal, VSCALE2	_	22.6	_	μΑ/MHz
peripherals disabled		39 MHz crystal	_	24.4	_	μΑ/MHz
		38 MHz HFRCO	_	19.0	_	µA/MHz
Current consumption in EM2 mode,	I <sub>EM2_VS</sub>	256 kB RAM and full Radio RAM retention, RTC running from LFXO <sup>1</sup>	_	2.9	_	μA
VSCALE0		256 kB RAM and full Radio RAM retention, RTC running from LFRCO <sup>1</sup>	_	2.9	_	μA
		16 kB RAM and full Radio RAM retention, RTC running from LFXO <sup>1</sup>	_	1.3	_	μA
		16 kB RAM and full Radio RAM retention, RTC running from LFRCO <sup>1</sup>	_	1.3	_	μΑ
		16 kB RAM and full Radio RAM retention, RTC running from LFRCO in precision mode <sup>1</sup>	_	1.9	_	μΑ
	I <sub>EM3_VS</sub>	256 kB RAM and full Radio RAM retention, RTC running from ULFRCO <sup>1</sup>	_	2.7	_	μΑ



Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Current consumption in EM3 mode, VSCALE0		16 kB RAM and full Radio RAM retention, RTC running from ULFRCO <sup>1</sup>	_	1.1	_	μΑ
Current consumption in EM4 mode	I <sub>EM4</sub>	No BURTC, No LF Oscillator	_	0.27	_	μΑ
		BURTC with LXO	_	0.64	_	μΑ
Current consumption during reset	I <sub>RST</sub>	Hard pin reset held	_	467	_	μΑ

# 4.4 Radio Current Consumption with 3 V Supply

RF current consumption measured with MCU in EM1 and all MCU peripherals disabled. Unless otherwise indicated, typical conditions are: VDD = 3.0 V, DC-DC in regulation.  $T_A = 25 \text{ °C}$ .

Table 7: Radio Current Consumption with 3.0 V Supply

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Current consumption in receive mode, active packet	I <sub>RX_ACTIVE</sub>	125 kbit/s, 2GFSK, f = 2.4 GHz	_	4.8	_	mA
reception, VSCALE1, EM1P		500 kbit/s, 2GFSK, f = 2.4 GHz	_	4.9	_	mA
		1 Mbit/s, 2GFSK, f = 2.4 GHz	_	4.5	_	mA
		2 Mbit/s, 2GFSK, f = 2.4 GHz	_	5.2	_	mA
Current consumption in receive mode, listening for	I <sub>RX_LISTEN</sub>	125 kbit/s, 2GFSK, f = 2.4 GHz	_	4.8	_	mA
packet, VSCALE1, EM1P		500 kbit/s, 2GFSK, f = 2.4 GHz	_	4.8	_	mA
		1 Mbit/s, 2GFSK, f = 2.4 GHz	_	4.5	_	mA
		2 Mbit/s, 2GFSK, f = 2.4 GHz	_	5.2	_	mA
Current consumption in transmit mode	I <sub>TX</sub>	f = 2.4 GHz, CW, 0 dBm output power	_	4.8	_	mA
transmit mode		f = 2.4 GHz, CW, +10 dBm output power	_	18.8	_	mA
		f = 2.4  GHz, CW, +20 dBm output power, VDD = 3.3 V <sup>1</sup>	_	154.8	_	mA

#### Note:

1. Maximum output power for Bluetooth Low Energy is limited to 19.6 dBm for compliance with the Bluetooth Core Specifications.

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<sup>1.</sup> CPU cache retained, EM0/EM1 peripheral states retained.



# 4.5 RF Transmitter General Characteristics for the 2.4 GHz Band

Unless otherwise indicated, typical conditions are: VDD = 3.0 V, DC-DC in regulation. RF center frequency 2.45 GHz.  $T_A=25^{\circ}C$ .

Table 8: RF Transmitter General Characteristics for the 2.4 GHz Band

Parameter	Symbol	Test Condition (Output Power)	Min	Тур	Max	Unit
RF tuning frequency range	F <sub>RANGE</sub>		2402	_	2480	MHz
Maximum TX power	POUT <sub>MAX</sub>	0 dBm	_	-0.3	_	dBm
		+10 dBm	_	10	_	dBm
		+20 dBm, $VDD = 3.3 V^1$	_	19.6	_	dBm
Minimum active TX Power	POUT <sub>MIN</sub>	0 dBm	_	-24	_	dBm
		+10 dBm	_	-30	_	dBm
		+20 dBm, VDD = 3.3 V	_	-33.7	_	dBm
Output power step size	POUTSTEP	0 dBm	0.1	0.7	9.9	dBm
		+10 dBm, -5 dBm < Output power < 0 dBm	0.6	1.1	1.8	dBm
		+10 dBm, 0 dBm < Output power < 10 dBm	0.1	0.3	0.8	dBm
		+20 dBm, VDD = 3.3 V, Output power < 0 dBm	0.9	3.6	14.4	dBm
		+20 dBm, 0 dBm < Output power < 20 dBm	0.1	0.2	1.3	dBm
Output power variation vs VDD supply voltage	POUT <sub>VAR_V</sub>	0 dBm with VDD voltage swept from 1.8 V to 3.8 V	_	0.01	_	dB
variation, frequency = 2450 MHz		+10 dBm with VDD voltage swept from 1.8 V to 3.8 V	_	0.05	_	dB
		+20 dBm with VDD voltage swept from 1.8 V to 3.8 V	_	5.4	_	dB
Output power variation vs	POUT <sub>VAR_T</sub>	0 dBm, (-40 to +105 °C)	_	1.0	_	dB
temperature, Frequency = 2450 MHz		+10 dBm, (-40 to +105 °C)	_	0.3	_	dB
		+20 dBm, VDD = 3.3 V, (-40 to +105 °C)	_	0.2	_	dB
Output power variation vs	POUT <sub>VAR_F</sub>	0 dBm	_	0.2	_	dB
RF frequency		+10 dBm	_	0.2	_	dB
		+20 dBm, VDD = 3.3 V	_	0.2	_	dB

#### Note:

1. Maximum output power for Bluetooth Low Energy is limited to 19.6 dBm for compliance with the Bluetooth Core Specifications.

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## 4.6 RF Receiver General Characteristics for the 2.4 GHz Band

Unless otherwise indicated, typical conditions are: VDD = 3.0 V, DC-DC in regulation. RF center frequency 2.45 GHz. T<sub>A</sub> = 25°C.

Table 9: RF Receiver General Characteristics for the 2.4 GHz Band

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
RF tuning frequency range	F <sub>RANGE</sub>		2402	_	2480	MHz

# 4.7 RF Receiver Characteristics for Bluetooth Low Energy in the 2.4 GHz Band 1 Mbps Data Rate

Unless otherwise indicated, typical conditions are: VDD = 3.0 V, DC-DC in regulation. RF center frequency 2.45 GHz. T<sub>A</sub> = 25

Table 10: RF Receiver Characteristics for Bluetooth Low Energy in the 2.4 GHz Band 1 Mbps Data Rate

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Max usable receiver input level	SAT	Signal is reference signal <sup>1</sup>	_	10	_	dBm
Sensitivity	SENS	+10 dBm Module, Signal is reference signal, 37 byte payload <sup>1</sup>	_	-98.5	_	dBm
		+10 dBm Module, Signal is reference signal, 255 byte payload <sup>1</sup>	_	-96.9	_	dBm
		+10 dBm Module, With non-ideal signals <sup>2</sup> 1	_	-96.5	_	dBm
		+20 dBm Module, Signal is reference signal, 37 byte payload <sup>1</sup>	_	-97.6	_	dBm
		+20 dBm Module, Signal is reference signal, 255 byte payload <sup>1</sup>	_	-96	_	dBm
		+20 dBm Module, With non-ideal signals <sup>2</sup> 1	_	-95.6	_	dBm
Signal to co- channel interferer	C/I <sub>CC</sub>	(see notes) <sup>1 3</sup>	_	8.7	_	dB
N ± 1 Adjacent channel	C/I <sub>1</sub>	Interferer is reference signal at +1 MHz offset <sup>1 3 4 5</sup>	_	-5.4	_	dB
selectivity		Interferer is reference signal at -1 MHz offset <sup>1 3 4 5</sup>	_	-5.3	_	dB
N ± 2 Alternate channel selectivity	C/I <sub>2</sub>	Interferer is reference signal at +2 MHz offset <sup>1 3 4 5</sup>	_	-40.9	_	dB
Selectivity		Interferer is reference signal at -2 MHz offset <sup>1 3 4 5</sup>	_	-39.7	_	dB
N ± 3 Alternate channel	C/I <sub>3</sub>	Interferer is reference signal at +3 MHz offset <sup>1 3 4 5</sup>	_	-45.5	_	dB
selectivity		Interferer is reference signal at -3 MHz	_	-45.7	_	dB



Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
		offset <sup>1 3 4 5</sup>				
Selectivity to image frequency	C/I <sub>IM</sub>	Interferer is reference signal at image frequency with 1 MHz precision 15	_	-23.3	_	dB
Selectivity to image frequency ± 1 MHz	C/I <sub>IM_1</sub>	Interferer is reference signal at image frequency +1 MHz with 1 MHz precision <sup>1 5</sup>	_	-40.9	_	dB
		Interferer is reference signal at image frequency -1 MHz with 1 MHz precision 15	_	-5.4	_	dB
Intermodulation performance	IM	n = 3 (see note <sup>6</sup> )	_	-17.3	_	dBm

- 1.0.017% Bit Error Rate.
- 2. With non-ideal signals as specified in Bluetooth Test Specification RF-PHY.TS.5.0.1 section 4.7.1
- 3. Desired signal -67 dBm.
- 4. Desired frequency 2402 MHz ≤ Fc ≤ 2480 MHz.
- 5. With allowed exceptions.
- 6. As specified in Bluetooth Core specification version 5.1, Vol 6, Part A, Section 4.4

# 4.8 RF Receiver Characteristics for Bluetooth Low Energy in the 2.4 GHz Band 2 Mbps Data Rate

Unless otherwise indicated, typical conditions are: VDD = 3.0 V, DC-DC in regulation. RF center frequency 2.45 GHz.  $T_A = 25 \text{ °C}$ .

Table 11: RF Receiver Characteristics for Bluetooth Low Energy in the 2.4 GHz Band 2 Mbps Data Rate

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Max usable receiver input level	SAT	Signal is reference signal <sup>1</sup>	_	10	_	dBm
Sensitivity	SENS	+10 dBm Module, Signal is reference signal, 37 byte payload <sup>1</sup>	_	-95.7	_	dBm
		+10 dBm Module, Signal is reference signal, 255 byte payload <sup>1</sup>	_	-94.2	_	dBm
		+10 dBm Module, With non-ideal signals <sup>2</sup>	_	-93.9	_	dBm
		+20 dBm Module, Signal is reference signal, 37 byte payload <sup>1</sup>	_	-94.8	_	dBm
		+20 dBm Module, Signal is reference signal, 255 byte payload <sup>1</sup>	_	-93.3	_	dBm
		+20 dBm Module, With non-ideal signals <sup>2</sup> 1	_	-93.1	_	dBm
Signal to co-channel interferer	C/I <sub>CC</sub>	(see notes) <sup>1 3</sup>	_	8.6	_	dB
N ± 1 Adjacent channel selectivity	C/I <sub>1</sub>	Interferer is reference signal at +2 MHz offset <sup>1543</sup>	_	-5.3	_	dB



Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
		Interferer is reference signal at -2 MHz offset <sup>1 5 4 3</sup>	_	-5.8	_	dB
N ± 2 Alternate channel selectivity	C/I <sub>2</sub>	Interferer is reference signal at +4 MHz offset <sup>1 5 4 3</sup>	_	-42.2	_	dB
		Interferer is reference signal at -4 MHz offset <sup>1543</sup>	_	-44.2	_	dB
N ± 3 Alternate channel selectivity	C/I <sub>3</sub>	Interferer is reference signal at +6 MHz offset <sup>1 5 4 3</sup>	_	-48.1	_	dB
		Interferer is reference signal at -6 MHz offset <sup>1 5 4 3</sup>	_	-50.2	_	dB
Selectivity to image frequency	C/I <sub>IM</sub>	Interferer is reference signal at image frequency with 1 MHz precision <sup>1 5</sup>	_	-22.8	_	dB
Selectivity to image frequency ± 2 MHz	C/I <sub>IM_1</sub>	Interferer is reference signal at image frequency +2 MHz with 1  MHz precision <sup>1 5</sup>	_	-42.2	_	dB
		Interferer is reference signal at image frequency -2 MHz with 1 MHz precision <sup>15</sup>	_	-5.3	_	dB
Intermodulation performance	IM	n = 3 (see note <sup>6</sup> )	_	-18.3	_	dBm

- 1.0.017% Bit Error Rate.
- 2. With non-ideal signals as specified in Bluetooth Test Specification RF-PHY.TS.5.0.1 section 4.7.1
- 3. Desired signal -64 dBm.
- 4. Desired frequency 2402 MHz ≤ Fc ≤ 2480 MHz.
- 5. With allowed exceptions.
- 6. As specified in Bluetooth Core specification version 5.1, Vol 6, Part A, Section 4.4

# 4.9 RF Receiver Characteristics for Bluetooth Low Energy in the 2.4 GHz Band 500 kbps Data Rate

Unless otherwise indicated, typical conditions are: VDD = 3.0 V, DC-DC in regulation. RF center frequency 2.45 GHz.  $T_A$  = 25 °C.

Table 12: RF Receiver Characteristics for Bluetooth Low Energy in the 2.4 GHz Band 500 kbps Data Rate

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Max usable receiver input level	SAT	Signal is reference signal <sup>1</sup>	_	10	_	dBm
Sensitivity SENS	SENS	+10 dBm Module, Signal is reference signal, 37 byte payload <sup>1</sup>	_	-102.2	_	dBm
		+10 dBm Module, Signal is reference signal, 255 byte payload <sup>1</sup>	_	-101	_	dBm
		+10 dBm Module, With non-ideal signals <sup>2</sup>	_	-100	_	dBm



Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
		+20 dBm Module, Signal is reference signal, 37 byte payload <sup>1</sup>	_	-101.4	_	dBm
		+20 dBm Module, Signal is reference signal, 255 byte payload <sup>1</sup>	_	-100	_	dBm
		+20 dBm Module, With non-ideal signals <sup>2</sup>	_	-99	_	dBm
Signal to co- channel interferer	C/I <sub>CC</sub>	(see notes) <sup>1 3</sup>	_	2.7	_	dB
N ± 1 Adjacent channel selectivity	C/I <sub>1</sub>	Interferer is reference signal at +1 MHz offset <sup>1 3</sup> 4 5	_	-7.1	_	dB
		Interferer is reference signal at -1 MHz offset <sup>1 3</sup> 4 5	_	-7.4	_	dB
N ± 2 Alternate channel	C/I <sub>2</sub>	Interferer is reference signal at +2 MHz offset <sup>1 3</sup> 4 5	_	-46.8	_	dB
selectivity		Interferer is reference signal at -2 MHz offset <sup>1 3</sup> 4 5	_	-49.7	_	dB
N ± 3 Alternate channel	C/I <sub>3</sub>	Interferer is reference signal at +3 MHz offset <sup>1 3</sup>	_	-49.4	_	dB
selectivity		Interferer is reference signal at -3 MHz offset <sup>1 3</sup> 4 5	_	-54.5	_	dB
Selectivity to image frequency	C/I <sub>IM</sub>	Interferer is reference signal at image frequency with 1 MHz precision <sup>1 5</sup>	_	-49	_	dB
Selectivity to image frequency	C/I <sub>IM_1</sub>	Interferer is reference signal at image frequency +1 MHz with 1	_	-49.4	_	dB
± 1 MHz		MHz precision <sup>1 5</sup>				
		Interferer is reference signal at image frequency -1 MHz with 1 MHz precision <sup>1 5</sup>	_	-46.8	_	dB

- 1. 0.017% Bit Error Rate.
- 2. With non-ideal signals as specified in Bluetooth Test Specification RF-PHY.TS.5.0.1 section 4.7.1
- 3. Desired signal -72 dBm.
- 4. Desired frequency 2402 MHz ≤ Fc ≤ 2480 MHz.
- 5. With allowed exceptions.

# 4.10 RF Receiver Characteristics for Bluetooth Low Energy in the 2.4 GHz Band 125 kbps Data Rate

Unless otherwise indicated, typical conditions are: VDD = 3.0 V, DC-DC in regulation. RF center frequency 2.45 GHz.  $T_A$  = 25 °C.

Table 13: RF Receiver Characteristics for Bluetooth Low Energy in the 2.4 GHz Band 125 kbps Data Rate

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Max usable	SAT	Signal is reference signal <sup>1</sup>	_	10	_	dBm



Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
receiver input level			'			
Sensitivity	SENS	+10 dBm Module, Signal is reference signal, 37 byte payload <sup>1</sup>	_	-106.5	_	dBm
		+10 dBm Module, Signal is reference signal, 255 byte payload <sup>1</sup>	_	-106.1	_	dBm
		+10 dBm Module, With non-ideal signals <sup>2 1</sup>	_	-105.7	_	dBm
		+20 dBm Module, Signal is reference signal, 37 byte payload <sup>1</sup>	_	-105.6	_	dBm
		+20 dBm Module, Signal is reference signal, 255 byte payload <sup>1</sup>	_	-105.3	_	dBm
		+20 dBm Module, With non-ideal signals <sup>2 1</sup>	_	-104.8	_	dBm
Signal to co- channel interferer	C/I <sub>CC</sub>	(see notes) <sup>1 3</sup>	_	0.9	_	dB
N ± 1 Adjacent channel selectivity	C/I <sub>1</sub>	Interferer is reference signal at +1 MHz offset <sup>1 3 4 5</sup>	_	-12.4	_	dB
		Interferer is reference signal at -1 MHz offset <sup>1 3 4 5</sup>	_	-12.8	_	dB
N ± 2 Alternate channel	C/I <sub>2</sub>	Interferer is reference signal at +2 MHz offset <sup>1 3 4 5</sup>	_	-52.6	_	dB
selectivity		Interferer is reference signal at -2 MHz offset <sup>1 3 4 5</sup>	_	-55.5	_	dB
N ± 3 Alternate	C/I <sub>3</sub>	Interferer is reference signal at +3 MHz offset <sup>1 3 4 5</sup>	_	-53.8	_	dB
selectivity		Interferer is reference signal at -3 MHz offset <sup>1 3 4 5</sup>	_	-60.0	_	dB
Selectivity to image frequency	C/I <sub>IM</sub>	Interferer is reference signal at image frequency with 1 MHz precision <sup>1 5</sup>	_	-53.0	_	dB
Selectivity to image	C/I <sub>IM_1</sub>	Interferer is reference signal at image frequency +1 MHz with 1	_	-53.8	_	dB
frequency ± 1 MHz		MHz precision <sup>1 5</sup>				
		Interferer is reference signal at image frequency -1 MHz with 1 MHz precision <sup>15</sup>	_	-52.6	_	dB



Parameter	Symbol	Test Condition	Min	Тур	Max	Unit

- 2. With non-ideal signals as specified in Bluetooth Test Specification RF-PHY.TS.5.0.1 section 4.7.1
- 3. Desired signal -79 dBm.
- 4. Desired frequency 2402 MHz ≤ Fc ≤ 2480 MHz.
- 5. With allowed exceptions.

# 4.11 High-Frequency Crystal

### Table 14: High-Frequency Crystal

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Crystal frequency	f <sub>HFXTAL</sub>		_	39	_	MHz
Initial calibrated accuracy	ACC <sub>HFXTAL</sub>		-10	±5	10	ppm
Temperature drift	DRIFT <sub>HFXTAL</sub>	Across specified temperature range	-20	_	20	ppm

# 4.12Low-Frequency Crystal Oscillator

Table 15: Low-Frequency Crystal Oscillator

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Crystal frequency	f <sub>LFXO</sub>		_	32.768	_	kHz
Supported Crystal equivalent	ESR <sub>LFXO</sub>	GAIN = 0	_	_	80	kOhms
series resistance (ESR)		GAIN = 1 to 3	_	_	100	kOhms
Supported range of crystal load	CL_LFXO	GAIN = 0	4	_	6	pF
capacitance <sup>1</sup>		GAIN = 1	6	_	10	pF
		GAIN = 2 (see note2)	10	_	12.5	pF
		GAIN = 3 (see note2)	12.5	_	18	pF
Current consumption	I <sub>CL12p5</sub>	ESR = 70 kΩ, CL = 12.5pF, GAIN <sup>3</sup> = 2, AGC <sup>4</sup> = 1	_	294	_	nA
Startup Time	TSTARTUP	ESR = 70 kΩ, CL = 7pF, GAIN <sup>3</sup> = 1, AGC <sup>4</sup> = 1	_	52	_	ms
On-chip tuning cap step size	SS <sub>LFXO</sub>		_	0.26	_	pF
On-chip tuning capacitor value at minimum setting <sup>5</sup>	CLFXO_MIN	CAPTUNE=0	_	5.2	_	pF
On-chip tuning capacitor value at maximum setting <sup>5</sup>	CLFXO_MAX	CAPTUNE=0x4F	_	26.2	_	pF

#### Note:

- 1. Total load capacitance seen by the crystal
- 2. Crystals with a load capacitance of greater than 12pF require external load capacitors.
- 3. In LFXO\_CAL Register
- 4. In LFXO\_CFG Register



Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
<ol><li>The effective load capacitar and the two caps will be see</li></ol>	•	ne crystal will be C <sub>LFXO</sub> /2. This is y the crystal	because each	XTAL pin h	as a tuni	ng cap,

# 4.13 Precision Low Frequency RC Oscillator (LFRCO)

## Table 16: Precision Low Frequency RC Oscillator (LFRCO)

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Nominal oscillation frequency	F <sub>LFRCO</sub>		_	32.768	_	kHz
Frequency accuracy	F <sub>LFRCO_ACC</sub>	Normal mode	-3	_	3	%
		Precision mode <sup>1</sup> , across operating temperature range <sup>2</sup>	- 500	_	500	ppm
Startup time	t <sub>STARTUP</sub>	Normal mode	_	204	_	μs
		Precision mode <sup>1</sup>	_	11.7	_	ms
Current consumption	I <sub>LFRCO</sub>	Normal mode	_	189.9	_	nA
		Precision mode1, T = stable at 25°C <sup>3</sup>	_	649.8	_	nA

#### Note:

- 1. The LFRCO operates in high-precision mode when CFG\_HIGHPRECEN is set to 1. High-precision mode is not available in EM4.
- 2. Includes ±40 ppm frequency tolerance of the HFXO crystal.
- 3. Includes periodic re-calibration against HFXO crystal oscillator.

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## 4.14GPIO Pins

#### Table 17: GPIO Pins

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Leakage current	I <sub>LEAK_IO</sub>	MODEx = DISABLED, VDD = 3.0 V	_	2.5	_	nA
Input low voltage <sup>1</sup>	$V_{IL}$	Any GPIO pin	_	_	0.3*VDD	V
		RESETn	_	_	0.3*DVDD	V
Input high voltage <sup>1</sup>	$V_{IH}$	Any GPIO pin	0.7*VDD	_	_	V
		RESETn	0.7*DVDD	_	_	V
Hysteresis of input	$V_{HYS}$	Any GPIO pin	0.05*VDD	_	_	V
voltage		RESETn	0.05*DVDD	_	_	V
Output low voltage	$V_{OL}$	Sinking 20mA, VDD = 3.0 V	_	_	0.2*VDD	V
Output high voltage	V <sub>OH</sub>	Sourcing 20mA, VDD = 3.0 V	0.8*VDD	_	_	V
GPIO rise time	$T_{GPIO\_RISE}$	VDD = 3.0V, C <sub>load</sub> = 50pF, SLEWRATE = 4, 10% to 90%	_	8.4	_	ns
GPIO fall time	$T_{GPIO_FALL}$	VDD = 3.0V, C <sub>load</sub> = 50pF, SLEWRATE = 4, 90% to 10%	_	7.1	_	ns
Pull up/down resistance <sup>2</sup>	R <sub>PULL</sub>	GPIO pull-up to VDD: MODEn = DISABLE, DOUT=1. GPIO pull- down to GND: MODEn = WIREDORPULLDOWN, DOUT = 0.	35	44	55	kΩ
		RESETn pin pull-up to DVDD.	35	44		kΩ
Maximum filtered glitch width	T <sub>GF</sub>	MODE = INPUT, DOUT = 1	_	27	_	ns
RESETn low time to ensure pin reset	T <sub>RESET</sub>		100	_	_	ns

#### Note:

- GPIO input thresholds are proportional to the VDD pin. RESETn input thresholds are proportional to the internal DVDD supply, which is generated by the DC-DC converter. DVDD is equal to 1.8 V when DC-DC is active and bypassed to VDD when DC-DC is inactive.
- 2. GPIO pull-ups connect to VDD supply, pull-downs connect to GND. RESETn pull-up connects to internal DVDD supply, which is generated by the DC-DC converter. DVDD is equal to 1.8V when DC-DC is active and bypassed to VDD when DC-DC is inactive.



# 4.15 Microcontroller Peripherals

The MCU peripherals set available in Lyra 24P modules includes:

- ADC: 12-bit at 1 Msps, 16-bit at 76.9 ksps
- 16-bit and 32-bit Timers/Counters
- 24-bit Low Energy Timer for waveform generation
- 32-bit Real Time Counter
- USART (UART/SPI/SmartCards/IrDA/I2S)
- EUSART (UART/IrDA)
- I<sup>2</sup>C peripheral interfaces
- 12 Channel Peripheral Reflex System

For details on their electrical performance and to learn which GPIO ports provide access to every peripheral, consult the relevant portions of Section 4 and Section 6 in the SoC datasheet, see EFR32BG24 SoC section for datasheet link.

To learn which GPIO ports provide access to every peripheral, consult Analog Peripheral Connectivity and Digital Peripheral Connectivity sections.

# 4.16Antenna Radiation and Efficiency for Lyra 24P Integrated Antenna

Typical performance curves indicate typical characterized performance under the stated conditions.

Typical Lyra 24P radiation patterns and efficiency for the integrated antenna under optimal operating conditions are plotted in the figures that follow. Antenna gain and radiation patterns have a strong dependence on the size and shape of the application PCB the module is mounted on, as well as on the proximity of any mechanical design to the antenna.



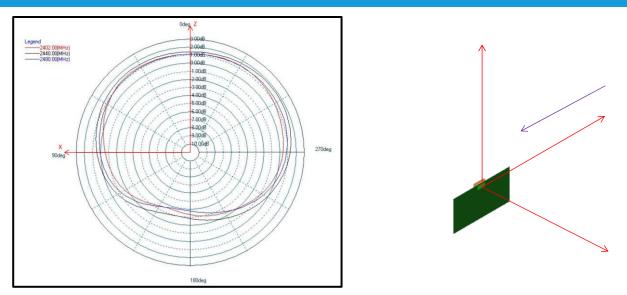


Figure 6: Lyra 24P Integrated Antenna Module Typical 2D Antenna Radiation Patterns - Phi 0º (Side View) Gain dBi

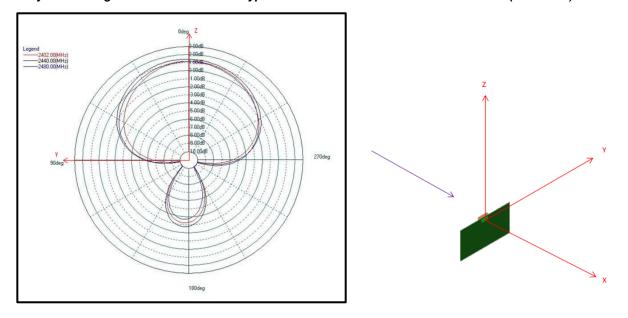


Figure 7: Lyra 24P Integrated Antenna Module Typical 2D Antenna Radiation Patterns - Phi 90° (Top View) Gain dBi



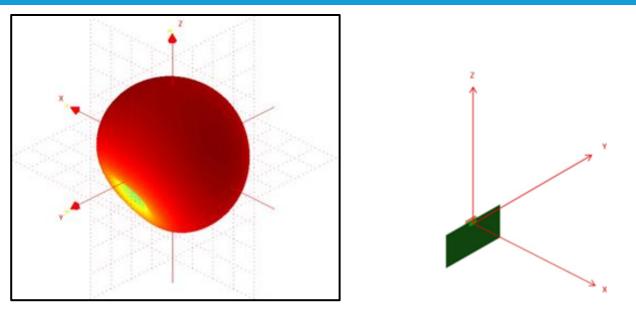


Figure 8: Lyra 24P Integrated Antenna Module Typical 2D Antenna Radiation Patterns - 3D Radiation Pattern at 2440 MHz

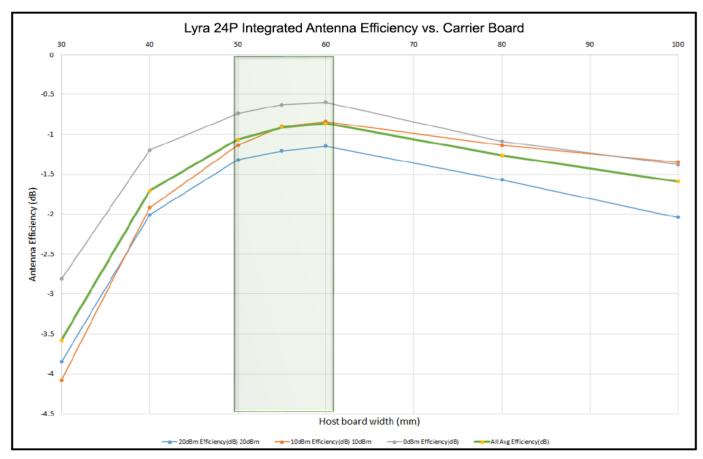


Figure 9: Radiation efficiency of the Built-in Antenna as Function of the Carrier Board Width(mm)



## 5 REFERENCE DIAGRAMS

# 5.1 Network Co-Processor (NCP) Application with UART Host

The Lyra 24P can be controlled over the UART interface as a peripheral to an external host processor. Typical power supply, programming/debug interface, and host interface connections are shown in the figure below. For more details, see AN958: Debugging and Programming Interfaces for Custom Designs.

**Note**: For boot pin, see section 5.3.

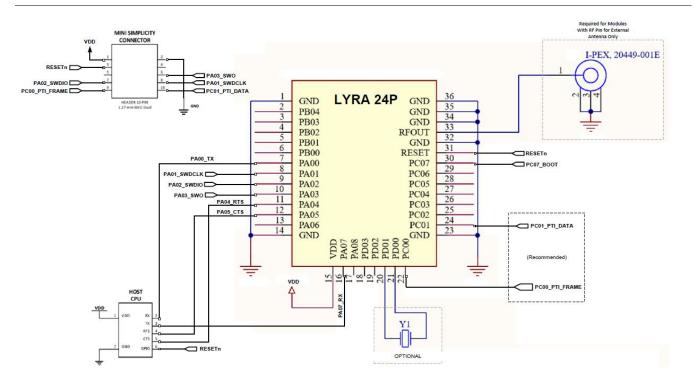


Figure 10: UART NCP Configuration (External Antenna MHF4 RF connector only required for 453-00148 Lyra 24P, RF trace pad variant module)

# 5.2 SoC Application

The Lyra 24P can be used in a stand-alone SoC configuration without an external host processor. Typical power supply and programming/debug interface connections are shown in the figure below. For more details, see AN958: Debugging and Programming Interfaces for Custom Designs.



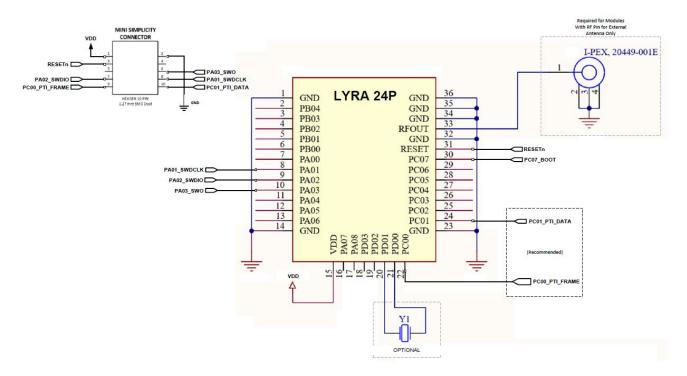


Figure 11: Stand-Alone SoC Configuration (External Antenna MHF4 RF connector only required for 453-00148 Lyra 24P, RF trace pad variant module)

## 5.3 Boot

The **BOOT** pin is used to determine when execution of the bootloader is required. Upon reset, execution of the bootloader begins. The **state** of the **BOOT** pin is read immediately upon start-up of the bootloader. If LOW, execution of the bootloader continues, facilitating firmware update via the UART. If the BOOT pin is HIGH, the bootloader will stop execution and pass control to the main application firmware.

https://www.lairdconnect.com/



# **6** PIN DEFINITIONS

# 6.1 Lyra 24P 36-Pin PCB Module Pinout

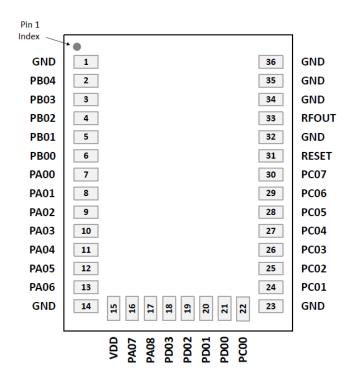


Figure 12: Lyra 24P 36-Pin PCB Module With LF Crystal Device Pinout

For GPIO pin to peripheral assignment in AT firmware, see User Guide - AT Interface Application - Lyra 24 Series.

The following table provides package pin connections and general descriptions of pin functionality. For detailed information on the supported features for each GPIO pin, see Table 19: GPIO Alternate Function Table, Analog Peripheral Connectivity, and Digital Peripheral Connectivity.

Table 18: Lyra 24P Module Pin Definitions

Pin Name	Pin(s)	Description	Pin Name	Pin(s)	Description
GND	1	Ground	PB04	2	GPIO
PB03	3	GPIO	PB02	4	GPIO
PB01	5	GPIO	PB00	6	GPIO
PA00	7	GPIO	PA01	8	GPIO
PA02	9	GPIO	PA03	10	GPIO
PA04	11	GPIO	PA05	12	GPIO
PA06	13	GPIO	GND	14	GND
VDD	15	Power Supply	PA07	16	GPIO
PA08	17	GPIO	PD03	18	GPIO
PD02	19	GPIO	PD01	20	GPIO / LF XTAL Input (Optional)



Pin Name	Pin(s)	Description	Pin Name	Pin(s)	Description
PD00	21	GPIO / LF XTAL Output (Optional)	PC00	22	GPIO
GND	23	GPIO	PC01	24	GPIO
PC02	25	GPIO	PC03	26	GPIO
PC04	27	GPIO	PC05	28	GPIO
PC06	29	GPIO	PC07	30	GPIO
RESETn	31	Reset Pin. The RESETn pin is pulled up to an internal DVDD supply. An external pull-up is not recommended. To apply an external reset source to this pin, it is required to only drive this pin low during reset, and let the internal pull-up ensure that reset is released. The RESETn pin can be left unconnected if no external reset switch or source is used.	GND	32	GND
RFOUT	33	RF Input/Output (External Ant.)	GND	34	GND
GND	35	GND	GND	36	GND

# 6.2 Alternate Function Table

Some GPIOs support alternate functions like debugging, wake-up from EM4, external low frequency crystal access, etc.. The following table shows which module pins have alternate capabilities and the functions they support. Refer to the SoC's reference manual for more details.

Table 19: GPIO Alternate Function Table

GPIO		Alternate Function	
PA00	IADC0.VREFP		
PA01	GPIO.SWCLK		
PA02	GPIO.SWDIO		
PA03	GPIO.SWV	GPIO.TDO	GPIO.TRACEDATA0
PA04	GPIO.TDI	GPIO.TRACECLK	
PA05	GPIO.TRACEDATA1	GPIO.EM4WU0	
PA06	GPIO.TRACEDATA2		
PA07	GPIO.TRACEDATA3		
PB00	VDAC0.VDAC_CH0_MAIN_OUTPUT		
PB01	GPIO.EM4WU3	VDAC0.VDAC_CH_MAIN_OUTPUT	
PB02	VDAC1.VDAC_CH0_MAIN_OUTPUT		
PB03	GPIO.EM4WU4	VDAC1.VDAC_CH1_MAIN_OUTPUT	
PC00	GPIO.EM4WU6		
PC01	GPIO.EFP_TX_SDA		



GPIO		Alternate Function	
PC02	GPIO.EFP_TX_SCL		
PC05	GPIO.EFP_INT	GPIO.EM4WU7	
PC07	GPIO.EM4WU8	GPIO.THMSW_EN	GPIO.THMSW_HALFSWITCH
PD00	LFXO.LFXTAL_O		
PD01	LFXO.LFXTAL_I	LFXO.LF_EXTCLK	
PD02	GPIO.EM4WU9		

# 6.3 Analog Peripheral Connectivity

Many analog resources are routable and can be connected to numerous GPIO's. The table below indicates which peripherals are available on each GPIO port. When a differential connection is being used, positive inputs are restricted to the EVEN pins and Negative inputs are restricted to the ODD pins. When a single ended connection is being used positive input is available on all pins. See the SoC's Reference Manual for more details on the ABUS and analog peripherals, EFR32BG24 SoC.

Table 20: ABUS Routing Table

Peripheral	Signal	PA		РВ		PC		PD	
renpheral	Signal	EVEN	ODD	EVEN	ODD	EVEN	ODD	EVEN	ODD
ACMP0	ana_neg	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes
	ana_pos	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes
ACMP1	ana_neg	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes
	ana_pos	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes
IADC0	ana_neg	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes
	ana_pos	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes
VDAC0	VDAC_CH0_ABUS_ OUTPUT	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes
	VDAC_CH1_ABUS_ OUTPUT	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes
VDAC1	VDAC_CH0_ABUS_ OUTPUT	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes
	VDAC_CH1_ABUS_ OUTPUT	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes



# 6.4 Digital Peripheral Connectivity

Many digital resources are routable and can be connected to numerous GPIO's. The table below indicates which peripherals are available on each GPIO port.

Table 21: DBUS Routing Table

Available Availa	Porinheral Bassuras			PORT	
Available Availa	Peripheral.Resource	PA	РВ	PC	PD
MULCLKINO Available Availa	ACMP0.DIGOUT	Available	Available	Available	Available
MUCLKOUTO Available Availa	ACMP1.DIGOUT			Available	Available
CMU.CLKOUT2 Available Available Available CUMU.CLKOUT2 Available EUSARTO.RTS Available Available Available EUSARTO.RX Available Available Available EUSARTO.SCLK Available Avail	CMU.CLKIN0			Available	Available
CMU.CLKOUT2 Available Available Available EUSARTO.CS Available Available Available Available Available Available Available Available Available EUSARTO.RTS Available Available Available EUSARTO.RX Available Available EUSARTO.RX Available Available EUSARTO.TX Available Availabl	CMU.CLKOUT0			Available	Available
EUSARTO.CS Available Available EUSARTO.CTS Available Available EUSARTO.RTS Available Available EUSARTO.RX Available Available EUSARTO.RX Available Available EUSARTO.SCLK Available Available EUSARTO.TX Available Available Available Available EUSARTI.CS Available Avai	CMU.CLKOUT1	Available	Available		
EUSARTO.CTS Available Available EUSARTO.RTS Available Available EUSARTO.RX Available Available EUSARTO.SCLK Available Available EUSARTO.TX Available Available EUSARTO.TX Available Available Available Available EUSARTI.CS Available Available Available Available Available EUSARTI.CTS Available Available Available Available Available EUSARTI.RTS Available Available Available Available Available EUSARTI.RX Available Available Available Available Available EUSARTI.TX Available Available Available Available Available EUSARTI.TX Available Available Available Available EUC.DCLK Available Available Available Available EUC.DOUT Available Available Available Available Available EUC.DOUT Available	CMU.CLKOUT2	Available	Available		
EUSARTO.RTS Available Available EUSARTO.RX Available Available EUSARTO.SCLK Available Available EUSARTO.TX Available Available Available EUSARTO.TX Available Available Available Available Available EUSART1.CS Available Available Available Available Available EUSART1.CTS Available Available Available Available Available EUSART1.RTS Available Available Available Available Available EUSART1.RTS Available Available Available Available Available EUSART1.RX Available Available Available Available Available EUSART1.TX Available Available Available Available Available Available EUSART1.TX Available Available Available Available Available Available EUSART1.TX Available Avai	EUSART0.CS	Available	Available		
EUSARTO.RX Available	EUSART0.CTS	Available	Available		
EUSARTO.SCLK Available EUSARTO.TX Available EUSART1.CTS Available	EUSART0.RTS	Available	Available		
EUSARTO.TX Available Available Available Available Available Available EUSART1.CS Available Available Available Available Available Available EUSART1.CTS Available Available Available Available Available EUSART1.RTS Available EUSART1.RX Available Available Available Available Available Available Available EUSART1.TX Available Available Available Available ERC.DCLK Available Available Available ERC.DOLK Available	EUSART0.RX	Available	Available		
Available	EUSART0.SCLK	Available	Available		
Available Available Available Available Available Available Available EUSART1.RTS Available	EUSART0.TX	Available	Available	Available	Available
Available	EUSART1.CS	Available	Available	Available	Available
Available	EUSART1.CTS	Available	Available	Available	Available
EUSART1.SCLK  Available	EUSART1.RTS	Available	Available	Available	Available
EUSART1.TX  Available Available Available FRC.DCLK  Available Available Available FRC.DFRAME  Available FRC.DOUT  Available	EUSART1.RX	Available	Available	Available	Available
FRC.DCLK FRC.DFRAME Available FRC.DOUT Available	EUSART1.SCLK	Available	Available	Available	Available
FRC.DFRAME  FRC.DOUT  Available	EUSART1.TX			Available	Available
FRC.DOUT Available	FRC.DCLK			Available	Available
HFXO0.BUFOUT_REQ_IN_ Available	FRC.DFRAME			Available	Available
ASYNC  2C0.SCL Available Available Available Available Available  2C0.SDA Available Available Available  2C1.SCL Available Available Available  2C1.SDA Available Available Available Available Available  3CEYSCAN.COL_OUT_0 Available Available Available Available	FRC.DOUT	Available	Available		
Available	HFXO0.BUFOUT_REQ_IN_ ASYNC	Available	Available	Available	Available
Available	I2C0.SCL	Available	Available	Available	Available
Available	I2C0.SDA			Available	Available
KEYSCAN.COL_OUT_0 Available Available Available Available	I2C1.SCL			Available	Available
	I2C1.SDA	Available	Available	Available	Available
(EYSCAN.COL_OUT_1 Available Available Available Available	KEYSCAN.COL_OUT_0	Available	Available	Available	Available
	KEYSCAN.COL_OUT_1	Available	Available	Available	Available



			PORT	
Peripheral.Resource	PA	РВ	PC	PD
KEYSCAN.COL_OUT_2	Available	Available	Available	Available
KEYSCAN.COL_OUT_3	Available	Available	Available	Available
KEYSCAN.COL_OUT_4				
KEYSCAN.COL_OUT_5	Available	Available	Available	Available
KEYSCAN.COL_OUT_6	Available	Available	Available	Available
KEYSCAN.COL_OUT_7	Available	Available	Available	Available
KEYSCAN.ROW_SENSE_0	Available	Available		
KEYSCAN.ROW_SENSE_1	Available	Available		
KEYSCAN.ROW_SENSE_2	Available	Available		
KEYSCAN.ROW_SENSE_3	Available	Available		
KEYSCAN.ROW_SENSE_4	Available	Available		
KEYSCAN.ROW_SENSE_5	Available	Available		
LETIMER0.OUT0	Available	Available		
LETIMER0.OUT1	Available	Available		
MODEM.ANT0	Available	Available	Available	Available
MODEM.ANT1	Available	Available	Available	Available
MODEM.ANT_ROLL_OVER			Available	Available
MODEM.ANT_RR0			Available	Available
MODEM.ANT_RR1			Available	Available
MODEM.ANT_RR2			Available	Available
MODEM.ANT_RR3			Available	Available
MODEM.ANT_RR4			Available	Available
MODEM.ANT_RR5			Available	Available
MODEM.ANT_SW_EN			Available	Available
MODEM.ANT_SW_US			Available	Available
MODEM.ANT_TRIG			Available	Available
MODEM.ANT_TRIG_STOP			Available	Available
MODEM.DCLK	Available	Available		
MODEM.DIN	Available	Available		
MODEM.DOUT	Available	Available		
PCNT0.S0IN	Available	Available		
PCNT0.S1IN	Available	Available		



			PORT	
Peripheral.Resource	PA	РВ	PC	PD
PRS.ASYNCH0	Available	Available		
PRS.ASYNCH1	Available	Available		
PRS.ASYNCH2	Available	Available		
PRS.ASYNCH3	Available	Available		
PRS.ASYNCH4	Available	Available		
PRS.ASYNCH5	Available	Available		
PRS.ASYNCH6			Available	Available
PRS.ASYNCH7			Available	Available
PRS.ASYNCH8			Available	Available
PRS.ASYNCH9			Available	Available
PRS.ASYNCH10			Available	Available
PRS.ASYNCH11			Available	Available
PRS.ASYNCH12	Available	Available		
PRS.ASYNCH13	Available	Available		
PRS.ASYNCH14	Available	Available		
PRS.ASYNCH15	Available	Available		
PRS.SYNCH0	Available	Available	Available	Available
PRS.SYNCH1	Available	Available	Available	Available
PRS.SYNCH2	Available	Available	Available	Available
PRS.SYNCH3	Available	Available	Available	Available
RAC.LNAEN	Available	Available	Available	Available
RAC.PAEN	Available	Available	Available	Available
TIMER0.CC0	Available	Available	Available	Available
TIMER0.CC1	Available	Available	Available	Available
TIMER0.CC2	Available	Available	Available	Available
TIMER0.CDTI0	Available	Available	Available	Available
TIMER0.CDTI1	Available	Available	Available	Available
TIMER0.CDTI2	Available	Available	Available	Available
TIMER1.CC0	Available	Available	Available	Available
TIMER1.CC1	Available	Available	Available	Available
TIMER1.CC2	Available	Available	Available	Available
TIMER1.CDTI0	Available	Available	Available	Available



	PORT			
Peripheral.Resource	PA	РВ	PC	PD
TIMER1.CDTI1	Available	Available	Available	Available
TIMER1.CDTI2	Available	Available	Available	Available
TIMER2.CC0	Available	Available		
TIMER2.CC1	Available	Available		
TIMER2.CC2	Available	Available		
TIMER2.CDTI0	Available	Available		
TIMER2.CDTI1	Available	Available		
TIMER2.CDTI2	Available	Available		
TIMER3.CC0			Available	Available
TIMER3.CC1			Available	Available
TIMER3.CC2			Available	Available
TIMER3.CDTI0			Available	Available
TIMER3.CDTI1			Available	Available
TIMER3.CDTI2			Available	Available
TIMER4.CC0	Available	Available		
TIMER4.CC1	Available	Available		
TIMER4.CC2	Available	Available		
TIMER4.CDTI0	Available	Available		
TIMER4.CDTI1	Available	Available		
TIMER4.CDTI2	Available	Available		
USART0.CLK	Available	Available	Available	Available
USART0.CS	Available	Available	Available	Available
USART0.CTS	Available	Available	Available	Available
USART0.RTS	Available	Available	Available	Available
USART0.RX	Available	Available	Available	Available
USART0.TX	Available	Available	Available	Available



#### 7 Design Guidelines

## 7.1 Layout and Placement

For optimal performance of the Lyra 24P:

Place the module aligned to the edge of the application PCB, as illustrated in the figures below.

- · Optional on the module with the RF pin.
- Leave the antenna clearance area void of any traces, components, or copper on all layers of the application PCB if
  you are going to use the built-in antenna.
- · Antenna clearance area is not necessary if you are using an external antenna attached to the RF pin.
- · RFOUT can be left floating if not used.

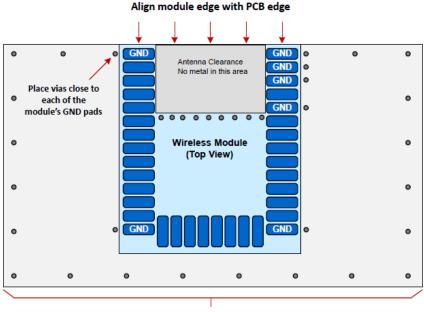
Antennas external to the module, either connectorized off-the-shelf antennas or PCB trace antennas, must be well-matched to  $50 \Omega$ .

- For external antenna use cases, use a 50 Ω grounded coplanar transmission line to trace the signal from the RF pin to an external MHF4 RF connector if applicable (see Figure 14).
- A general rule is to use 50  $\Omega$  transmission lines where the length of the RF trace is longer than  $\lambda/16$  at the fundamental frequency, which for 2.4 GHz is approximately 3.5 mm.
- An IPEX MHF4 RF connector can be used in the host PCB for the connection to an external antenna. The use of a
  MHF4 connector is also recommended for conductive tests. The integrator must use a unique connector, such as a
  "reverse polarity SMA" or "reverse thread SMA", if detachable antenna is offered with the host chassis. This is
  especially required for the FCC and ISED approvals to remain valid, and any other kind of direct connector to the
  antenna might require a permissive change.
- A trace length of 1.84 mm was used in the certifications host board to connect the module RF pin to the MHF4 RF connector.
- For reference, Figure 18 shows a set of parameters for a 50 Ω trace. Trace impedance should always be matched to the particular stack-up used on the host board.

Connect all ground pads directly to a solid ground plane.

Place the ground vias as close to the ground pads as possible.

Avoid plastic or any other dielectric material in contact with the antenna.



Place vias along all PCB edges

Figure 13: Recommended Layout for Lyra 24P Using Built-in Antenna



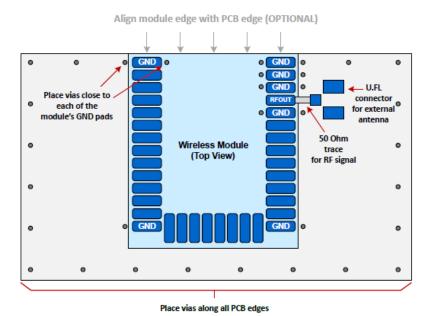


Figure 14: Recommended Layout for Lyra 24P Using External Antenna

The figure below illustrates layout scenarios that will lead to severely degraded RF performance for the module.

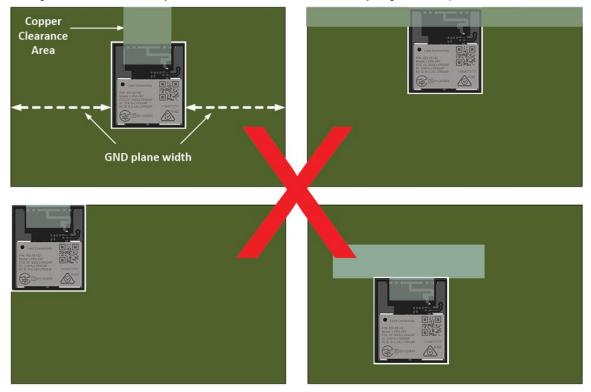


Figure 15: Non-optimal layout examples

The width of the GND plane to the sides the module will impact the efficiency of the built in antenna. **To achieve optimal performance**, a **GND plane width of 55-60 mm is recommended**. See Antenna Radiation and Efficiency for reference.

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# 7.2 Proximity to Other Materials

Avoid plastic or any other dielectric material in close contact with the antenna. Conformal coating and other thin dielectric layers are acceptable directly on top of the antenna region, but this will also negatively impact antenna efficiency and reduce range.

Any metallic objects in close proximity to the antenna will prevent the antenna from radiating freely. The minimum recommended distance of metallic and/or conductive objects is 10 mm in any direction from the antenna except in the directions of the application PCB ground planes.

# 7.3 Proximity to Human Body

Placing the module in contact with or very close to the human body will negatively impact antenna efficiency and reduce range.

#### 7.4 Reset

The Lyra 24P can be reset by pulling the RESET line low, by the internal watchdog timer, or by software command. The reset state does not provide power saving functionality and it is not recommended as a means to conserve power.

## 7.5 Debug

The Lyra 24P supports hardware debugging via 4-pin JTAG or 2-pin serial-wire debug (SWD) interfaces. It is recommended to expose the debug pins in your own hardware design for firmware update and debug purposes. The table below lists the required pins for JTAG and SWD debug interfacing, which are also presented in Section Alternate Function Table.

If JTAG interfacing is enabled, the module must be power cycled to return to a SWD debug configuration if necessary. Table 22: Debug Pins

Pin Name	JTAG Signal	SWD Signal	Comments
PA04	TDI	N/A	This pin is disabled after reset. Once enabled the pin has a built-in pull-up.
PA03	TDO	N/A	This pin is disabled after reset.
PA02	TMS	SWDIO	Pin is enabled after reset and has a built-in pull-up.
PA01	TCK	SWCLK	Pin is enabled after reset and has a built-in pull-down.

# 7.6 Packet Trace Interface (PTI)

The Lyra 24P integrates a true PHY-level packet trace interface (PTI) peripheral that can capture packets non-intrusively to monitor and log device and network traffic without burdening processing resources in the module's SoC. The PTI generates two output signals that can serve as a powerful debugging tool, especially in conjunction with other hardware and software development tools available from Silicon Labs. The PTI\_DATA and PTI\_FRAME signals can be accessed through any GPIO on ports C and D (see FRC.DOUT and FRC.DFRAME peripheral resources in Pin Definitions.

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# 7.7 Lyra 24P Module 50 Ohms RF Track Design for Connecting External Antenna with the Lyra 24P Module, 20dBm, RF Pad Variant (453-00148)

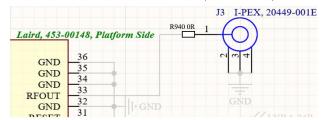
Lyra 24P module can be used with external antennas (certified by Laird Connectivity), and requires a 50 Ohm RF trace (GCPW, that Grounded Coplanar Waveguide) to be designed to run from Lyra 24P module RFOUT (pin33) to a RF antenna connector (IPEX MHF4) on host PCB. The **50 Ohms RF track design and length MUST be copied** (as specified in this section). Lyra 24P module GND pin32 and GND pin34 used to support GCPW 50Ohm RF trace.

#### **Checklist for SCH**

#### Lyra 24P External antenna connection SCH

#### Lyra 24P External antenna connection PCB

1. Fit IPEX MHF4 RF connector (20449-001E)



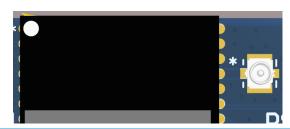
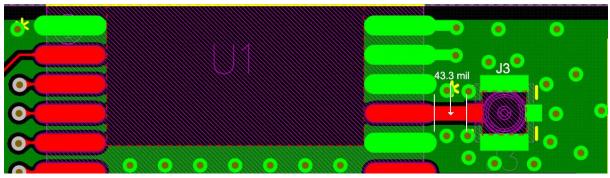


Figure 16: Lyra 24P for External antenna connection host PCB 50-Ohm RF trace schematic with MHF4 RF connector Layer1 (RF Track and RF GND)



Layer2 (RF GND)

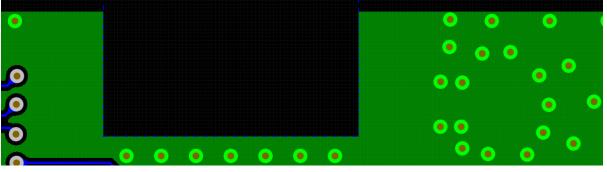
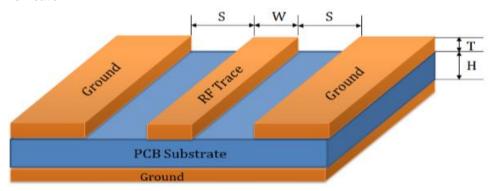


Figure 17: 50-Ohm RF trace design (Layer1 and Layer2) on DVK-Lyra 24P development board 453-00148-K1 (or host PCB) for use with Lyra 24P (453-00148) module



#### **Checklist for PCB:**

- MUST use a 50-Ohm RF trace (GCPW, that is Grounded Coplanar Waveguide) from RFOUT pad (pin33) of the Lyra 24P module (453-00148) to RF antenna connector (IPEX MHF4 Receptable (MPN: 20449-001E)) on host PCB.
- To ensure regulatory compliance, MUST follow exactly the following considerations for 50-Ohms RF trace design and test verification:



	Thickness		Dielectric	
	mil	mm	Constant Er	
Solder Mask	1.0	0.025	3.5	
Layer1 Copper 1oz+plating	1.5	0.038		
Core	57.60	1.463	4.2	Stack up for 50 Ohms GCPW  RF Track.
Layer2 Copper 1oz+plating	1.5	0.038		
Solder Mask	1.0	0.025	3.5	
Total	62.6	1.59		

Figure 18: Lyra 24P development board PCB stack-up and 50-Ohms Grounded CPW RF trace design using GND on L1 and L2

Note 1: The plating (ENIG) above base 1 ounce copper is not listed, but plating expected to be ENIG.

- The 50-Ohms RF trace design MUST be Grounded Coplanar Waveguide (GCPW) with
  - Layer1 RF track width (W) of 20 mil and
  - Layer1 gap (S) to GND of 5 mil and where the
  - Layer1 to Layer 2 dielectric thickness (H) MUST be 57.6 mil (dielectric constant Er 4.2).
  - Further the Layer1 base copper must be 1-ounce base copper (that is 1.5 mil) plus the plating and
  - Layer1 MUST be covered by solder mask of 1.0 mill thickness (dielectric constant Er 3.5).
- The 50-Ohms RF trace design MUST follow the PCB stack-up shown in Figure 18. (Layer1 to Layer2 thickness MUST be identical to the Lyra 24P development board).
- The 50-Ohms RF track should be a controlled-impedance trace e.g., ±10%.
- The 50-Ohms RF trace length MUST be identical (as seen in Figure 17) (43.3mil) to that on the Lyra 24P development board from Lyra 24P module RFOUT RF pad (pin33) to the RF connector IPEX MHF4 Receptable (MPN: 20449-001E).
- Place GND vias regularly spaced either side of 50-Ohms RF trace to form GCPW (Grounded coplanar waveguide) transmission line as shown in Figure 17 and use Lyra 24P module GND pin32, GND pin34.
- Use spectrum analyzer to confirm the radiated (and conducted) signal is within the certification limit.



# 7.8 External Antenna Integration with the Lyra 24P Module, 20dBm, RF pad variant (453-00148)

Please refer to the Lyra 24P Regulatory Information Guide (coming soon) for details on using Lyra 24P module with external antennas in each regulatory region. This guide will be available at: <a href="https://www.lairdconnect.com/lyra24-series">www.lairdconnect.com/lyra24-series</a>.

The Lyra 24P has been designed to operate with the below external antennas (with a maximum gain of 2.0dBi). The required antenna impedance is 50 ohms. See Table 23. External antennas improve radiation efficiency.

Table 23: External antennas for the Lyra 24P

		Laird					Peal	c Gain
Manufacturer	Model	Connectivity Part Number	Weight	Dimensions	Type	Connector	2400-2500 MHz	2400-2480 MHz
Laird Connectivity	NanoBlue	EBL2400A1- 10MH4L		44.45mm x 12.7mm x 0.81 mm	PCB Dipole	IPEX MHF4	2 dBi	-
Laird Connectivity	FlexPIFA	001-0022	1.13g	40.1mm x 11.0mm x 2.5mm	PIFA	IPEX MHF4	-	2 dBi
Mag Layers	EDA-8709- 2G4C1-B27- CY	0600-00057	NA	NA	Dipole	IPEX MHF4	2 dBi	-
Laird Connectivity	mFlexPIFA	EFA2400A3S- 10MH4L	1.8g	25.4 mm × 23.4 mm × 2.5 mm	PIFA	IPEX MHF4	-	2 dBi



# 8 MECHANICAL SPECIFICATIONS

# 8.1 Dimensions (Lyra 24P series modules)

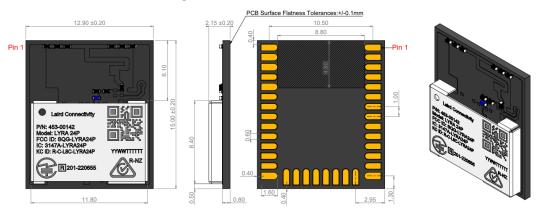


Figure 19: LYRA 24P +10 dBm Module dimensions (mm)

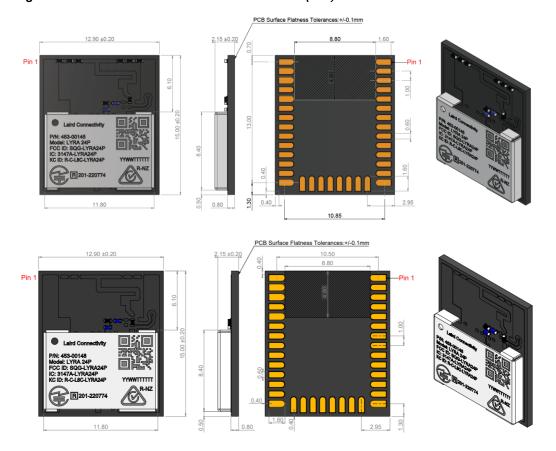


Figure 20: LYRA 24P +20 dBm Module, Integrated Antenna (453-00145) and LYRA 24P +20 dBm Module, RF Trace pad variant (453-00148) dimensions (mm)



# 8.2 PCB Land Pattern (Lyra 24P series modules)

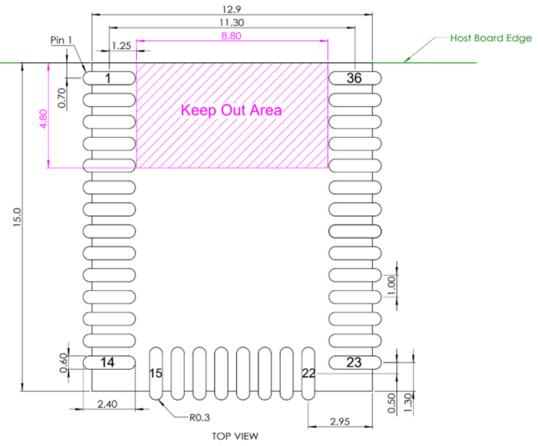


Figure 21: PCB land pattern

Note: For modules with RF pin, the antenna keep out zone in the PCB land pattern above should be omitted.



# 8.3 Dimensions for 450-00184 Lyra 24P - Bluetooth v5.4 USB Adaptor (20dBm) with Integrated Antenna (Silicon Labs EFR32BG24)

The Lyra 24P USB dongle User Guide is available on the Lyra 24 Series product page:

https://www.lairdconnect.com/lyra24-series

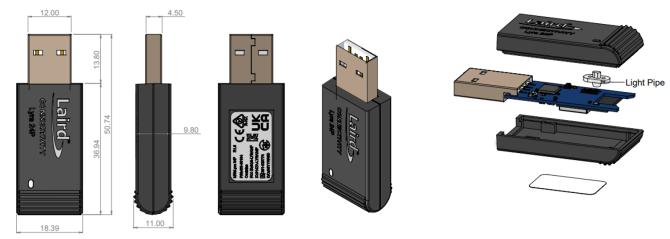


Figure 22: Lyra 24P USB Module - Dimensions



# 8.4 Lyra 24P Series Module Label Marking

The figure below shows the module markings engraved on the RF shield.





Figure 23: Lyra 24P Top Marking – +10dBm (Integrated antenna), +20 dBm (integrated antenna) and +20 dBm (RF pad) Modules Shown

#### **Mark Description**

The package marking consists of:

- P/N Part number designation
- Model: Lyra 24P Model number designation
- QR Code: YYWWTTTTTT
  - YY Last two digits of the assembly year.
  - WW Two-digit workweek when the device was assembled.
  - TTTTTT Manufacturing trace code. The first two letters are the ID of the manufacturer followed by 4 digits of trace code.
- Date code: YYWWTTTTTT
  - YY Last two digits of the assembly year.
  - WW Two-digit workweek when the device was assembled.
  - TTTTTT Manufacturing trace code. The first two letters are the ID of the manufacturer followed by 4 digits of trace code.
- Certification marks such as the CE logo, FCC, and IC IDs, etc as per above image.

Hong Kong: +852-2762-4823



# 8.5 Lyra 24P USB Adapter Label Marking



Figure 24: Lyra 24P USB Adapter Label Marking

#### **Mark Description**

The package marking consists of:

- P/N Part number designation
- Model: Lyra 24P Model number designation
- Date Code: YYWWTTTTTT
  - YY Last two digits of the assembly year.
  - WW Two-digit workweek when the device was assembled.
  - TTTTTT Manufacturing trace code. The first two letters are the ID of the manufacturer followed by 4 digits of trace code.
- Certification marks such as the CE logo, FCC, and IC IDs, etc as per above image.

# 8.6 Lyra 24P USB Adapter Antenna Radiation Pattern

The Lyra 24P USB adaptor uses the 453-000145 - Lyra 24P Series - Bluetooth v5.4 PCB Module (20dBm) with integrated antenna module which has 1.82dBi antenna gain.

The Lyra 24P USB adaptor small PCB size (small ground plane) limits the radiated antenna performance. See Lyra 24P USB adaptor antenna patterns in X, Y and Z orientations for 3 channels.

Table 24: Lyra 24P USB Adapter antenna gain (X, Y, and Z planes)

Antenna Gain in dBi	240	2MHz	244	0MHz	248	0MHz
Antenna Gam in ubi	Peak	Average	Peak	Average	Peak	Average
X plane Azimuth	-5.72dBi	-8.22dBi	-4.82dBi	-7.02dBi	-4.56dBi	-6.82dBi
X plane Elevation	-22.71dBi	-27.82Bi	-21.38dBi	-27.04dBi	-21.06dBi	-26.77dBi
Y plane Azimuth	-17.24dBi	-22.9dBi	-16.11dBi	-20.98dBi	-16.69dBi	-21.09dBi
Y plane Elevation	-6.1dBi	-8.68dBi	-4.83dBi	7.27dBi	-4.08dBi	-6.54dBi
Z plane Azimuth	-7.36dBi	-12.78dBi	-6.07dBi	-11.62dBi	-5.61dBi	-11.18dBi
Z plane Elevation	-6.48dBi	-10.82dBi	-4.79dBi	-9.47dBi	-4.21dBi	-8.93dBi



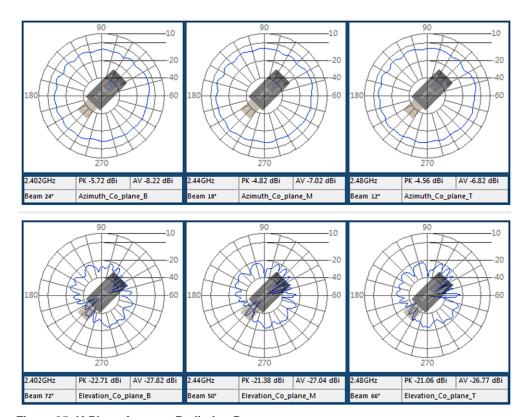


Figure 25: X-Plane Antenna Radiation Pattern

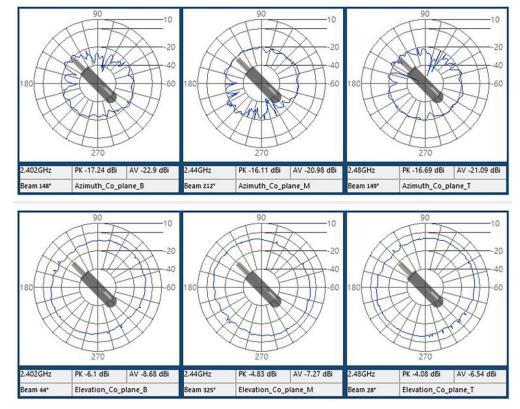


Figure 26: Y-Plane Antenna Radiation Pattern



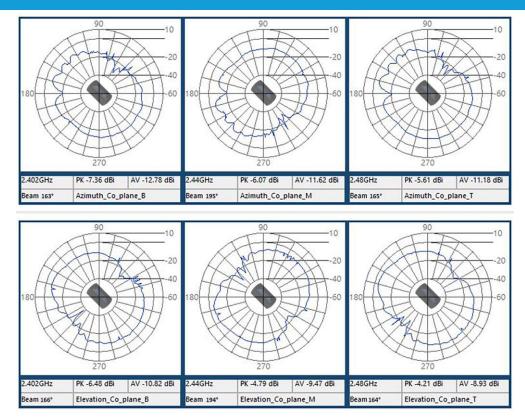


Figure 27: Z-Plane Antenna Radiation Pattern

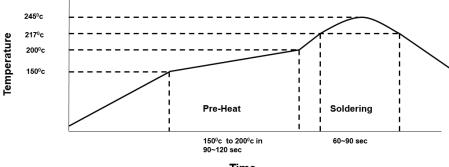


#### SOI DERING RECOMMENDATIONS

#### 9.1 Reflow for lead Free Solder Paste

- Optimal solder reflow profile depends on solder paste properties and should be optimized as part of an overall process development.
- It is important to provide a solder reflow profile that matches the solder paste supplier's recommendations.
- Temperature ranges beyond that of the solder paste supplier's recommendation could result in poor solderability.
- All solder paste suppliers recommend an ideal reflow profile to give the best solderability.

# 9.2 Recommended Reflow Profile for lead Free Solder Paste



Time

Figure 28: Recommended Reflow Profile



## 10 MISCELLANEOUS

# 10.1 Cleaning

In general, cleaning the populated modules is strongly discouraged. Residuals under the module cannot be easily removed with any cleaning process.

- Cleaning with water can lead to capillary effects where water is absorbed into the gap between the host board and the
  module. The combination of soldering flux residuals and encapsulated water could lead to short circuits between
  neighboring pads. Water could also damage any stickers or labels.
- Cleaning with alcohol or a similar organic solvent will likely flood soldering flux residuals into the RF shield, which is not
  accessible for post-washing inspection. The solvent could also damage any stickers or labels.
- Ultrasonic cleaning could damage the module permanently.

#### 10.2Rework

The Lyra 24P module can be unsoldered from the host board if the Moisture Sensitivity Level (MSL) requirements are met as described in this datasheet.

Never attempt a rework on the module itself, i.e. replacing individual components. Such actions terminate warranty coverage.

# 10.3 Handling and Storage

#### 10.3.1 Handling

The Lyra 24P module contain a highly sensitive electronic circuitry. Handling without proper ESD protection may damage the module permanently.

#### 10.3.2 Moisture Sensitivity Level (MSL)

Per J-STD-020, devices rated as MSL 4 and not stored in a sealed bag with desiccant pack should be baked prior to use.

Devices are packaged in a Moisture Barrier Bag with a desiccant pack and Humidity Indicator Card (HIC). Devices that will be subjected to reflow should reference the HIC and J-STD-033 to determine if baking is required.

If baking is required, refer to J-STD-033 for bake procedure.

#### 10.3.3Storage

Per J-STD-033, the shelf life of devices in a Moisture Barrier Bag is 12 months at <40C and <90% room humidity (RH).

Do not store in salty air or in an environment with a high concentration of corrosive gas, such as Cl2, H2S, NH3, SO2, or NOX. Do not store in direct sunlight.

The product should not be subject to excessive mechanical shock.

#### 10.3.4Repeated Reflow Soldering

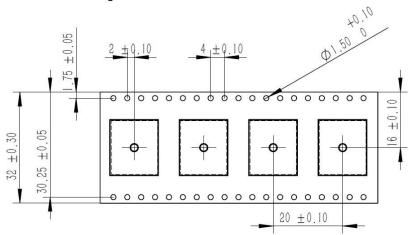
Only a single reflow soldering process is encouraged for host boards.

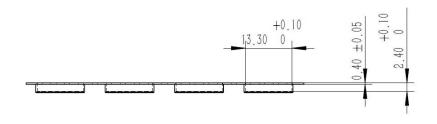
https://www.lairdconnect.com/



# 11 TAPE AND REEL

Lyra 24P modules are delivered to the customer in cut tape (250 pcs) or reel (1000 pcs) packaging with the dimensions below. All dimensions are given in mm unless otherwise indicated.





+0.10

Figure 29: Carrier Tape Dimensions

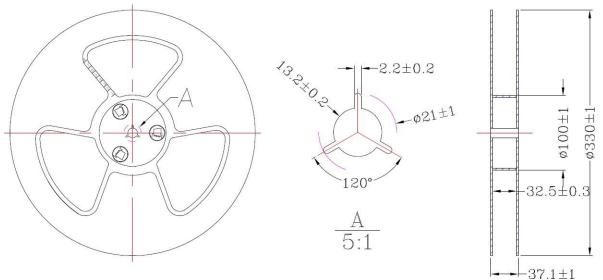


Figure 30: Reel Dimensions



# 12 RELIABILITY TEST

# 12.1 Climatic And Dynamic

Table 25: Climatic and Dynamic Reliability Test Results for Lyra 24P Modules

Test Item	Specification	Standard	Test Result
	Pre-check:		
	1. Function check (Tools and SOP supplied by customers).		
	2. Mechanical check.		
	Pre-conditioning:		
	1. Bake: 125°C for 24 hours.		
	2. Moisture Soak: 30°C/60% RH for 192 hours		
Step 1: Pre- conditioning	<ol> <li>Not shorter than 15 minutes and not longer than 4 hours after removal from the temperature/humidity chamber, subject the sample to 3 cycles of the reflow.</li> </ol>	JESD22-A113	Pass
	Post-check:		
	4. Function check (Tools and SOP supplied by customers).		
	5. Mechanical check.		
	<ol><li>Perform inspections of short, open, delamination of DUTs by Optical Microscope (under 40X optical magnification).</li></ol>		
	7. X-RAY / CSAM (SAT) on any failed samples (Notify customers).		
	8. Cross-sections analysis based on X-RAY and CSAM results.		
	9. Dwell on -40°C for 15 minutes		
Step 2:	10. Shock to 85°C within ramp rate 15 °C/minute		
Temperature Cycling	11. Dwell on 85°C for 15 minutes	JESD22-A113	Pass
Non-operating	12. Shock to -40°C within ramp rate 15 degree C/minute		
	13. Repeat step 1-4 and stop to check functions at 500/700 cycles		
Machanical	Pulse shape: Half-sine waveform		
Mechanical Shock	2. Impact acceleration: 1500 g	JEDEC 22-	
Non-operating	3. Pulse duration: 0.5 ms	B110B.01	Pass
Unpackaged device	4. Number of shocks: 30 shocks (5 shocks for each face)	(2019)	
GEVICE	5. Orientation: Bottom, top, left, right, front, and rear faces		



Table 26: Climatic and Dynamic Reliability Test Results for Lyra 24P USB Adapter

Test Item	Specification	Standard	Test Result
Thermal Shock	<ol> <li>Temperature: -40 ~ 85°C</li> <li>Ramp time: Less than 10 seconds.</li> <li>Dwell Time: 10 minutes</li> <li>Number of Cycles: 500 times</li> </ol>	*JESD22-A106 *IEC 60068-2-14 for dwell time and number of cycles	Pass
Vibration Non-operating Unpackaged device	<ol> <li>Vibration Wave Form: Sine Waveform</li> <li>Vibration frequency / Displacement: 20-80 Hz/1.5mm</li> <li>Vibration frequency / Acceleration: 80-2000 Hz/20g</li> <li>Cycle Time: 4 min/cycle</li> <li>Number of Cycles: 4 cycle/axis</li> <li>Vibration Axes: X, Y and Z (Rotate each axis on vertical vibration table)</li> </ol>	JEDEC 22-B103B (2016)	Pass
Mechanical Shock Non-operating Unpackaged device	<ol> <li>Pulse shape: Half-sine waveform</li> <li>Impact acceleration: 1500 g</li> <li>Pulse duration: 0.5 ms</li> <li>Number of shocks: 30 shocks (5 shocks for each face)</li> <li>Orientation: Bottom, top, left, right, front and rear faces</li> </ol>	JEDEC 22-B110B.01 (2019)	Pass



# 12.2 Reliability MTBF Prediction

#### Table 27: MTBF Prediction for Lyra 24P Modules

Laird Part Number	Environment	Test Result 40 ℃ (Hours)
453-00142R		
453-00142C		
453-00145R	Cround Fixed Uncentralled	17,000,000
453-00145C	Ground, Fixed, Uncontrolled	17,000,000
453-00148R		
453-00148C		

Laird Part Number	Environment	Test Result 105 ℃ (Hours)
453-00142R		
453-00142C		
453-00145R	Cround Fixed Uncentralled	900,000
453-00145C	Ground, Fixed, Uncontrolled	900,000
453-00148R		
453-00148C		

#### Table 28: MTBF Prediction for Lyra 24P USB Adapter

Laird Part Number	Environment	Test Result 40 ℃ (Hours)
450-00184	Ground, Fixed, Uncontrolled Ground, Mobile	1,311,381.23 2,608,428.88
Laird Part Number	Environment	Test Result 85 ℃ (Hours)



# 13 REGULATORY

# 13.1 Regulatory information

**Note:** For complete regulatory information, refer to the Lyra 24P Regulatory Information document (coming soon) which will be available from the Lyra 24 Series Bluetooth 5.4 Solution Product page.

The Lyra 24P holds current certifications in the following countries:

#### Table 29: Lyra 24P Regulatory Information

Country/Region	Regulatory ID		
USA (FCC)	SQG-LYRA24P		
Canada (ISED)	3147A-LYRA24P		
UK (UKCA)	N/A		
EU	N/A		
Japan (MIC)	201-220655 (+10 dBm) / 201-220774 (+20 dBm)		
Korea (KC)	R-C-L8C-LYRA24P (Module)		
Notea (NO)	R-C-L8C-LYRA24PUSB (USB Adapter)		
Australia (AS)	N/A		
New Zealand (NZS)	N/A		



# 13.2 Maximum Regulatory Certified RF TX Power per Country - 453-00148 Lyra 24P Series - Bluetooth v5.4 PCB Module (20dBm) with RF Trace Pad

#### 13.2.1 For shipped AT firmware

AT firmware implements RF TX power settings per country highlighted in below table and per country sections have detailed information.

	Country and implementation	Global	EU	UK	USA	Canada	Australia	New Zealand	Japan	South Korea
AT FW	Region code	GL	EU	UK	US	CA	AU	NZ	JP	SK
AFH FW module?	Turned on or off	on	on	on	on	on	on	on	on	on
20dBm mode (>15 BLE	Target TX power conducted	17dBm	17dBm	17dBm	17dBm	17dBm	17dBm	17dBm	17dBm	17dBm
channels free)	Antenna Gain setting.	3.5dBi	3.5dBi	3.5dBi	3.5dBi	3.5dBi	3.5dBi	3.5dBi	3.5dBi	3.5dBi
	TX power setting	20dBm	20dBm	20dBm	20dBm	20dBm	20dBm	20dBm	20dBm	20dBm
	Turn off CH39 2480MHz	yes	no	no	yes	yes	no	no	no	no
10dBm mode (<15 BLE	Target TX power conducted	7dBm	7dBm	7dBm	7dBm	7dBm	7dBm	7dBm	7dBm	7dBm
channels free)	Antenna Gain setting.	3.5dBi	3.5dBi	3.5dBi	3.5dBi	3.5dBi	3.5dBi	3.5dBi	3.5dBi	3.5dBi
	TX power setting	10dBm	10dBm	10dBm	10dBm	10dBm	10dBm	10dBm	10dBm	10dBm

453-00148 Lyra 24P - Bluetooth v5.4 PCB Module (20dBm) with RF Trace Pad is shipped with AT firmware where the radio regulatory region "global" is set which is lowest common settings across RF TX power across certified countries.

To switch to the specific radio regulatory region country of USA, Canada, Europe, UK, Australia, New Zealand, Japan, and South Korea, customer can use appropriate AT command for setting the radio regulatory region per country.

#### 13.2.2 For customers C code development

Customers developing with C Code - Full software development with Silicon Labs SDK and Toolchain, MUST implement the RF TX power settings per country and other parameters mentioned in this section.

#### 13.2.3 AFH firmware module

1) For BLE 20dBm modules, and whenever for radio regulatory declared radio as FHSS, the Silabs AFH FW module MUST be enabled. See Silabs AFH firmware module (in Silabs BLE stack) operation description: https://docs.silabs.com/bluetooth/5.0/general/system-and-performance/adaptive-frequency-hopping

#### Below is basic summary:

- a. Does spectral scanning every one second (takes about 10ms to scan 40 BLE channels) AFTER first transmission (after an advertisement is sent)
- b. If RF interference is present on a channel (above -71dBm), then that channel is NOT used and is blacklisted for at least 8 afh\_scan\_intervals
- c. You are allowed to use TX power above +10 dBm when AFH is enabled and at least 15 channels are available
- Note that high transmit power is only allowed once for each channel after a measurement on that channel occurs. In other words, if you use the same channel multiple times for transmitting within afh\_scan\_interval, the second and consecutive transmission will use +10 dBm. If you have a short connection interval and long afh\_scan\_interval, this can easily happen,

Americas: +1-800-492-2320 Europe: +44-1628-858-940

Hong Kong: +852-2762-4823



- e. Other limitations:
  - "When AFH is applied, the length of the connection events (not to be confused with the connection interval) is limited to 40 ms. In other words, in every connection interval you can send packets only for 40 ms. This is usually not a problem because it takes around 2.5 ms to transmit a packet with 251B payload. However, to achieve maximum throughput with unacknowledged data transmission (see Throughput with Bluetooth Low Energy, you have to take into account this limitation. For example, if you have 100 ms connection interval, you can send packets only 40% of the time. To achieve maximum throughput, decrease your connection interval to 40 ms or lower."
- 2) AFH FW module has high 20dBm mode and lower 10dBm mode (in both cases actual RF TX power is lower as per Laird Connectivity certified tables).
- 3) AFH FW module uses high (20dBm) mode when at least 15 BLE channels are available.
- 4) AFH FW module uses low (10dBm) mode If the number of available BLE channels are less than 15. E.g. when using legacy BLE Advert (which has only 3 BLE channels namely 2402, 2440, 2480MHz), then the AFH FW module drops to 10dBm mode.
  - NOTE: In both cases actual RF TX power is lower as per below Laird certified table.
- 5) Why is Antenna Gain **setting** used? Implemented (in AT firmware) lower RF TX power (for both 20dBm and 10dBm modes) than certified in 10dBm mode. Reason for this is the 10dBm mode TX power setting is hardcoded to 10dBm (by Silabs), so to achieve Laird certified TX power e.g. 7dBm for CE (which is lower than 10dBm for CE), the method of using Antenna Gain **setting** is used to produce the actual TX power that Laird certified in the 10dBm mode. Since Antenna Gain **setting** applies to both 10dBm mode and 20dBm mode and all countries, so it impacts RF TX power across both modes (20dBm and 10dBm modes) and countries.

  Silabs BLE SDK 5.0.0.0 GA (December 14, 2022) version does NOT allow TX power setting in 10dBm mode to be modified.



# 13.2.4 Europe (CE), UK (UKCA), Australia (RCM, New Zealand (RCM) Radio RF TX power Table

Table 30: 20dBm mode - Europe (CE), UK (UKCA), Australia (RCM, New Zealand (RCM) Radio TX power table

Module Lair	d Part number	453-00148						
Description		Lyra 24P - Blue	tooth v5.4 PCB M	lodule (20dBm) w	vith RF Trace Pad (Silic	on Labs EFR32BG24	)	
Antenna Gai	in (dBi)	2.0dBi peak ext	ernal antenna					
Radio Regula	atory country:	Europe (CE), UI	K (UKCA), Austra	lia (RCM) and Ne	w Zealand (RCM)			
Declared as I	FHSS or DTS?	FHSS (uses Silal	os AFH FW modu	le ON)				
AFH FW mod	dule?	AFH firmware r	module turned Of	N.				
Silabs BLE SD	OK:	5.0.0.0 GA (Ded	cember 14, 2022)					
Silabs Gecko	bs Gecko SDK Suite: 4.2 (December 14, 2022).							
20dBm mode. Declared as FHSS.	e. ared HSS.				CERTIFIED LOWEST COMMON RF TX power setting across BLE PHY's, other restrict	IMPLEMENTED in customer MUST i developed C-cod AFH firmware mo	mplement in c e. odule turned C	oustomers own
	NOTE1				NOTE2	NOTE3	NOTE4A	NOTE4B
BLE PHY	Physical channel (channel Index)	Frequency (MHz) channel centre.	Certified conducted Maximum TX Power setting dBm	Certified measured Conducted Peak POWER (dBm)	Certified Lowest common conducted RF TX power setting across all 4 BLE data rates.	Target RF TX power conducted to implement in FW. Other restrictions (if any).	Antenna Gain setting in FW	Conducted TX power setting in FW
BLE 1Mbps	CH0 (CH37)	2402 MHz	17dBm	17.41dBm	17dBm	17dBm	3.5dBi	20dBm
	CH39 (CH39)	2480 MHz	17dBm	17.14 dBm	17dBm	17dBm	3.5dBi	20dBm
BLE 2Mbps	CH1 (CH0)	2404 MHz	17dBm	17.44dBm	17dBm	17dBm	3.5dBi	20dBm
	CH38 (CH36)	2478 MHz	17dBm	17.22dBm	17dBm	17dBm	3.5dBi	20dBm
BLE	CH0 (CH37)	2402 MHz	17dBm	17.40dBm	17dBm	17dBm	3.5dBi	20dBm
125kbps	CH39 (CH39)	2480 MHz	17dBm	17.10dBm	17dBm	17dBm	3.5dBi	20dBm
BLE	CH0 (CH37)	2402 MHz	17dBm	17.40dBm	17dBm	17dBm	3.5dBi	20dBm
500kbps	CH39 (CH39)	2480 MHz	17dBm	17.15dBm	17dBm	17dBm	3.5dBi	20dBm

Table 31: 10dBm mode - Europe (CE), UK (UKCA), Australia (RCM, New Zealand (RCM) Radio TX power table

10dBm mode. Declared as DTS.	CERTIFIED maxim	um conducted R	F TX power per B	LE PHY	CERTIFIED LOWEST COMMON RF TX power setting across BLE PHY's, other restrict	COMMON RF TX power setting across BLE PHY's,			
	NOTE1				NOTE2	NOTE3	NOTE4A	NOTE4B	
BLE PHY	Physical channel (channel Index)	Frequency (MHz) channel centre.	Certified conducted Maximum TX Power setting dBm	Certified Measured Conducted Peak POWER (dBm)	Certified Lowest common conducted RF TX power setting across all 4 BLE data rates.	Target RF TX power conducted to implement in FW. Other restrictions (if any).	Antenna Gain setting in FW	TX power setting in FW	
BLE 1Mbps	CH0 (CH37)	2402 MHz	7dBm	7.58dBm	7dBm	7dBm	3.5dBi	10dBm	
	CH39 (CH39)	2480 MHz	7dBm	7.20dBm	7dBm	7dBm	3.5dBi	10dBm	
BLE 2Mbps	CH1 (CH0)	2404 MHz	7dBm	7.59dBm	7dBm	7dBm	3.5dBi	10dBm	
	CH38 (CH36)	2478 MHz	7dBm	7.25dBm	7dBm	7dBm	3.5dBi	10dBm	
BLE	CH0 (CH37)	2402 MHz	7dBm	7.58dBm	7dBm	7dBm	3.5dBi	10dBm	
125kbps	CH39 (CH39)	CH39 (CH39) 2480 MHz 7dBm 7.20dBm				7dBm	3.5dBi	10dBm	
BLE	CH0 (CH37)	2402 MHz	7dBm	7.58dBm	7dBm	7dBm	3.5dBi	10dBm	
500kbps	CH39 (CH39)	2480 MHz	7dBm	7.20dBm	7dBm	7dBm	3.5dBi	10dBm	



**NOTE1**: CERTIFIED maximum conducted RF TX power per BLE PHY in 20dBm mode or 10dBm mode tables. This is not what is implemented in AT firmware, this is what was certified only.

**NOTE2**: Certified Lowest common TX power setting across BLE PHY's. This lowest common TX power setting is stated since we do not use **per BLE** RF TX power setting in AT firmware, but same TX power setting across all 4 BLE PHY's.

**NOTE3**: IMPLEMENT in AT firmware **target** RF TX power conducted. This target actual implemented in AT firmware. For CE, UKCA, RCM (Australia and New Zealand), this is actual target 17dBm conducted (in 20dBm mode) and 7dBm conducted (in 10dBm mode). To implement that, NOTE4A defines what Antenna Gain setting MUST be used and NOTE4B defines what TX power setting MUST be used.

**NOTE4**: IMPLEMENTED in AT firmware (or MUST implement in customers own developed C-code) the Actual target RF TX power conducted:

NOTE4A: the Antenna Gain setting of 3.5dBi and

NOTE4B: the TX power setting to 20dBm (in 20dBm mode) and 10dBm (in 10dBm mode).

which results in:

Target Actual RF TX power (dBm) = TX power setting (dBm) - Antenna Gain setting(dBi)

17dBm = 20dBm - 3.5dBi7dBm = 10dBm - 3.5dBi



# 13.2.5 USA (FCC), Canada (ISED) Radio RF TX power Table

Table 32: 20dBm mode - USA (FCC), Canada (ISED) Radio TX power table

Module La	ird Part	453-00148										
number												
Descriptio	n	Lyra 24P - Blu	uetooth v5.4 PCB	Module (20dBr	n) with RF Trace Pad (Silicon Labs	EFR32BG24)						
Antenna G	ain (dBi)	2.0dBi peak e	external antenna	·								
Radio Regi	ulatory		ANADA (ISED)									
country:												
Declared a	s FHSS or DTS?	FHSS (uses Si	labs AFH FW mo	dule ON)								
AFH FW m	odule?	AFH firmware	AFH firmware module turned ON.									
Silabs BLE	SDK:	5.0.0.0 GA (D	5.0.0.0 GA (December 14, 2022).									
Silabs Gecl	ko SDK Suite:	4.2 (Decemb	4.2 (December 14, 2022).									
20dBm	CERTIFIED max	CERTIFIED maximum conducted RF TX power per BLE PHY										
mode.					COMMON RF TX power	FW or customer	•					
FHSS.					setting across BLE PHY's,	customers own	•					
					other restrict	AFH firmware m	odule turned	I ON.				
	NOTE4				NOTES	NOTE3	NOTEAA	NOTEAR				
BLE PHY	NOTE1	F	Certified	Certified	NOTE2  Certified Lowest common		NOTE4A	NOTE4B TX				
BLE PHY	Physical channel	Frequency (MHz)	conducted	Measured	conducted RF TX power	Target RF TX	Antenna Gain	power				
	(channel	channel	Maximum	Conducted	setting across all 4 BLE data	power conducted to	setting in	setting				
	Index)	centre.	TX Power	Peak	rates.	implement in	FW	in FW				
	illuex)	centre.	setting dBm	POWER	Tates.	FW. Other	FVV	III FVV				
			Setting abin	(dBm)		restrictions (if						
				(dBiii)		any).						
BLE	CH0 (CH37)	2402MHz	20dBm	19.95dBm	17dBm	17dBm	3.5dBi	20dBm				
1Mbps	CH19 (CH17)	2440MHz	20dBm	19.93dBm	17dBm	17dBm	3.5dBi	20dBm				
·	CH38 (CH36)	2478MHZ	18dBm	18.10dBm	17dBm	17dBm	3.5dBi	20dBm				
	CH39 (CH39)	2480MHz	15dBm	15.53dBm	Turn OFF CH39 (2480MHz)	Turn OFF CH39 (	2480MHz) in	FW.				
BLE	CH1 (CH0)	2404MHz	20dBm	19.94dBm	17dBm	17dBm	3.5dBi	20dBm				
2Mbps	CH19 (CH17)	2440MHz	20dBm	19.92dBm	17dBm	17dBm	3.5dBi	20dBm				
	CH38 (CH36)	2478MHz	17dBm	17.21dBm	17dBm	17dBm	3.5dBi	20dBm				
BLE	CH0 (CH37)	2402MHz	20dBm	19.94dBm	17dBm	17dBm	3.5dBi	20dBm				
coded	CH19 (CH17)	2440MHz	20dBm	19.91dBm	17dBm	17dBm	3.5dBi	20dBm				
PHY	CH38 (CH36)	2478MHz	18dBm	18.09dBm	17dBm	17dBm	3.5dBi	20dBm				
125kbps	CH39 (CH39)	2480MHz	15dBm	15.52dBm	Turn OFF CH39 (2480MHz)	Turn OFF CH39 (	2480MHz) in	FW.				
BLE	CH0 (CH37)	2402MHz	20dBm	19.93dBm	17dBm	17dBm	3.5dBi	20dBm				
coded	CH19 (CH17)	2440MHz	20dBm	19.90dBm	17dBm	17dBm	3.5dBi	20dBm				
PHY	CH38 (CH36)	2478MHz	18dBm	18.08dBm	17dBm	17dBm	3.5dBi	20dBm				
500kbps	CH39 (CH39)	2480MHz	15dBm	15.51dBm	Turn OFF CH39 (2480MHz)	Turn OFF CH39 (	2480MHz) in	FW.				

Table 33: 10dBm mode - USA (FCC), Canada (ISED) Radio TX power table

10dBm mode. DTS.	CERTIFIED maxim	um conducted R	F TX power per B	LE PHY	CERTIFIED LOWEST COMMON RF TX power setting across BLE PHY's, other restrict	Implemented in L customer MUST i developed C-code AFH firmware mo	mplement in c e.	ustomers own
	NOTE1				NOTE2	NOTE3	NOTE4A	NOTE4B
BLE PHY	Physical channel (channel Index)	Frequency (MHz) channel centre.	Certified conducted Maximum TX Power setting dBm	Certified Measured Conducted Peak POWER (dBm)	Certified Lowest common conducted RF TX power setting across all 4 BLE data rates.	Target RF TX power conducted to implement in FW. Other restrictions (if any).	Antenna Gain setting in FW	TX power setting in FW
BLE 1Mbps	CH0 (CH37)	2402MHz	10dBm	10.32dBm	10dBm	7dBm	3.5dBi	10dBm
	CH19 (CH17)	2440MHz	10dBm	10.18dBm	10dBm	7dBm	3.5dBi	10dBm
	CH38 (CH36)	2478MHz	10dBm	10.05dBm	10dBm	7dBm	3.5dBi	10dBm
	CH39 (CH39)	2480MHz	10dBm	10.02dBm	10dBm	7dBm	3.5dBi	10dBm
BLE 2Mbps	CH1 (CH0)	2404MHz	10dBm	10.31dBm	10dBm	7dBm	3.5dBi	10dBm
	CH19 (CH17)	2440MHz	10dBm	10.17dBm	10dBm	7dBm	3.5dBi	10dBm



	CH38 (CH36)	2478MHz	10dBm	10.03dBm	10dBm	7dBm	3.5dBi	10dBm
BLE coded	CH0 (CH37)	2402MHz	10dBm	10.30dBm	10dBm	7dBm	3.5dBi	10dBm
PHY	CH19 (CH17)	2440MHz	10dBm	10.17dBm	10dBm	7dBm	3.5dBi	10dBm
125kbps	CH38 (CH36)	2478MHz	10dBm	10.02dBm	10dBm	7dBm	3.5dBi	10dBm
	CH39 (CH39)	2480MHz	10dBm	10.01dBm	10dBm	7dBm	3.5dBi	10dBm
BLE coded	CH0 (CH37)	2402MHz	10dBm	10.29dBm	10dBm	7dBm	3.5dBi	10dBm
PHY	CH19 (CH17)	2440MHz	10dBm	10.16dBm	10dBm	7dBm	3.5dBi	10dBm
500kbps	CH38 (CH36)	2478MHz	10dBm	10.02dBm	10dBm	7dBm	3.5dBi	10dBm
	CH39 (CH39)	2480MHz	10dBm	10.01dBm	10dBm	7dBm	3.5dBi	10dBm

**NOTE1**: CERTIFIED maximum conducted RF TX power per BLE PHY in 20dBm mode or 10dBm mode tables. This is not what is implemented in AT firmware, this is what was certified only.

**NOTE2**: Certified Lowest common TX power setting across BLE PHY's **is 17dBm AND BLE CH39 2480MHz** is **turned OFF**. Why do we turn OFF BLE CH39 2480MHz is because the CH39 2480MHz RF TX power that FCC, ISED pass was achieved at 15dBm, which is lower than 17dBm achieved at some of the other BLE channels. To use the lowest common RF TX power setting of 17dBm AND MUST turn OFF BLE channel CH39 2480MHz.

**NOTE3**: IMPLEMENT in AT firmware **target** RF TX power conducted. This target actual implemented in AT firmware. For FCC (USA), ISED (Canada), this is actual 17dBm conducted (in 20dBm mode) and 7dBm conducted (in 10dBm mode). To implement that, NOTE4A defines what Antenna Gain setting MUST be used and NOTE4B defines what TX power setting MUST be used.

**NOTE4**: IMPLEMENTED in AT firmware (or MUST implement in customers own developed C-code) the Actual target RF TX power conducted:

NOTE4A: the Antenna Gain setting of 3.5dBi and

NOTE4B: the TX power setting to 20dBm (in 20dBm mode) and 10dBm (in 10dBm mode).

which results in:

Target Actual RF TX power (dBm) = TX power setting (dBm) - Antenna Gain setting(dBi)

17dBm = 20dBm - 3.5dBi7dBm = 10dBm - 3.5dBi

#### 13.2.6 Australia (RCM, New Zealand (RCM) Radio RF TX power Table

Same as EU (CE). Refer to Europe (CE), UK (UKCA), Australia (RCM, New Zealand (RCM) Radio RF TX power Table.

Hong Kong: +852-2762-4823



# 13.2.7 Japan (MIC) Radio RF TX power Table

Table 34: 20dBm mode - Japan (MIC) Radio TX power table

Module Lair	d Part number	453-00148									
Description			tooth v5.4 PCB M	odule (20dBm) w	rith RF Trace Pad (Silico	on Labs EFR32BG24	)				
Antenna Gai	n (dBi)	2.0dBi peak ext	ernal antenna		,						
	atory country:	Japan (MIC)									
	FHSS or DTS?	<u> </u>	os AFH FW modu	le ON)							
AFH FW mod	dule?	,	AFH firmware module turned ON.								
Silabs BLE SD	OK:	5.0.0.0 GA (Dec	5.0.0.0 GA (December 14, 2022).								
Silabs Gecko	SDK Suite:	4.2 (December 14, 2022).									
			•								
20dBm	CERTIFIED maxim	IFIED maximum conducted RF TX power per BLE PHY CERTIFIED IMPLEMENTED in Laird Connectivity AT FW o									
mode.					LOWEST	customer MUST i	mplement in c	ustomers own			
FHSS.					COMMON RF TX	developed C-code	₽.				
					power setting	AFH firmware module turned ON.					
					across BLE PHY's,						
					other restrict		1	1			
	NOTE1				NOTE2	NOTE3	NOTE4A	NOTE4B			
BLE PHY	Physical	Frequency	Certified	Certified	Certified Lowest	Target RF TX	Antenna	Conducted			
	channel	(MHz)	conducted	measured	common	power	Gain	TX power			
	(channel Index)	channel	Maximum TX	Conducted	conducted RF TX	conducted to	setting in	setting in FW			
		centre.	Power	Peak POWER	power setting	implement in	FW				
			setting dBm	(dBm)	across all 4 BLE	FW. Other					
					data rates.	restrictions (if					
DIE 104bas	CH0 (CH37)	2402 MHz	18dBm	18.50dBm	18dBm	any). 17dBm	3.5dBi	20dBm			
BLE 1Mbps	_ , ,	2402 MHz	20dBm	18.50dBm 17.54dBm	18dBm	17dBm 17dBm	3.5dBi	20dBm 20dBm			
BLE 2Mbps	CH39 (CH39) CH1 (CH0)	2480 MHz	18dBm	17.54dBm 18.22dBm	18dBm	17dBm 17dBm	3.5dBi	20dBm 20dBm			
PLE ZIVIDPS	- (/		18dBm		18dBm	17dBm 17dBm		20dBm 20dBm			
BLE	CH38 (CH36) CH0 (CH37)	2478 MHz 2402 MHz	18dBm 18dBm	18.02dBm 18.49dBm	18dBm	17dBm 17dBm	3.5dBi 3.5dBi	20dBm 20dBm			
125kbps	. ,	2402 MHz	18dBm	18.49dBm 18.30dBm	18dBm	17dBm 17dBm	3.5dBi	20dBm 20dBm			
•	CH39 (CH39)										
BLE	CH0 (CH37)	2402 MHz	18dBm	18.21dBm	18dBm	17dBm	3.5dBi	20dBm			
500kbps	CH39 (CH39)	2480 MHz	18dBm	18.10dBm	18dBm	17dBm	3.5dBi	20dBm			

Table 35: 10dBm mode - Japan (MIC) Radio TX power table

10dBm mode. DTS.	CERTIFIED maxim	um conducted Ri	F TX power per B	LE PHY	CERTIFIED LOWEST COMMON RF TX power setting across BLE PHY's, other restrict	IMPLEMENTED in customer MUST i developed C-code AFH firmware mo	mplement in c e.	ustomers own
	NOTE1				NOTE2	NOTE3	NOTE4A	NOTE4B
BLE PHY	Physical channel (channel Index)	Frequency (MHz) channel centre.	Certified conducted Maximum TX Power setting dBm	Certified Measured Conducted Peak POWER (dBm)	Certified Lowest common conducted RF TX power setting across all 4 BLE data rates.	Target RF TX power conducted to implement in FW. Other restrictions (if any).	Antenna Gain setting in FW	TX power setting in FW
BLE 1Mbps	CH0 (CH37)	2402 MHz	9dBm	9.76dBm	9dBm	7dBm	3.5dBi	10dBm
	CH39 (CH39)	2480 MHz	9dBm	9.48dBm	9dBm	7dBm	3.5dBi	10dBm
BLE 2Mbps	CH1 (CH0)	2404 MHz	9dBm	9.74dBm	9dBm	7dBm	3.5dBi	10dBm
	CH38 (CH36)	2478 MHz	9dBm	9.49dBm	9dBm	7dBm	3.5dBi	10dBm
BLE	CH0 (CH37)	2402 MHz	9dBm	9.73dBm	9dBm	7dBm	3.5dBi	10dBm
125kbps	CH39 (CH39)	2480 MHz	9dBm	9.43dBm	9dBm	7dBm	3.5dBi	10dBm
BLE	CH0 (CH37)	2402 MHz	9dBm	9.76dBm	9dBm	7dBm	3.5dBi	10dBm
500kbps	CH39 (CH39)	2480 MHz	9dBm	9.46dBm	9dBm	7dBm	3.5dBi	10dBm



**NOTE1**: CERTIFIED maximum conducted RF TX power per BLE PHY in 20dBm mode or 10dBm mode tables. This is not what is implemented in AT firmware, this is what was certified only.

**NOTE2**: Certified Lowest common TX power setting across BLE PHY's. This lowest common TX power setting is stated since we do <u>not</u> use **per BLE** RF TX power setting in AT firmware, but same TX power setting across all 4 BLE PHY's.

**NOTE3**: IMPLEMENT in AT firmware **target** RF TX power conducted. This target actual implemented in AT firmware. For Japan, this is the actual target 17dBm conducted (in 20dBm mode) and 7dBm conducted (in 10dBm mode). To implement that, NOTE4A defines what Antenna Gain setting MUST be used and NOTE4B defines what TX power setting MUST be used.

**NOTE4**: IMPLEMENTED in AT firmware (or MUST implement in customers own developed C-code) the Actual target RF TX power conducted:

NOTE4A: the Antenna Gain setting of 3.5dBi and

NOTE4B: the TX power setting to 20dBm (in 20dBm mode) and 10dBm (in 10dBm mode).

which results in:

 $Target\ Actual\ RF\ TX\ power\ (dBm) = TX\ power\ \textbf{setting}\ (dBm)\ -\ Antenna\ Gain\ \textbf{setting}\ (dBi)$ 

17dBm = 20dBm - 3.5dBi7dBm = 10dBm - 3.5dBi



# 13.2.8 South Korea Radio RF TX power Table

Table 36: 20dBm mode - South Korea TX power table

Module Lair	d Part number	453-00148								
Description		Lyra 24P - Blue	tooth v5.4 PCB M	lodule (20dBm) w	vith RF Trace Pad (Silic	on Labs EFR32BG24	)			
Antenna Gai	in (dBi)	2.0dBi peak ext	ernal antenna							
Radio Regula	atory country:	South Korea (S	K)							
Declared as I	FHSS or DTS?	FHSS (uses Silal	os AFH FW modu	le ON)						
AFH FW mod	dule?	AFH firmware r	AFH firmware module turned ON.							
Silabs BLE SD	DK:	5.0.0.0 GA (December 14, 2022).								
Silabs Gecko	SDK Suite:	4.2 (December 14, 2022).								
20dBm mode. FHSS.	node. eHSS.					IMPLEMENTED in customer MUST i developed C-code AFH firmware mo	mplement in c e. odule turned O	N.		
	NOTE1				NOTE2	NOTE3	NOTE4A	NOTE4B		
BLE PHY	Physical	Frequency	Certified	Certified	Certified Lowest	Target RF TX	Antenna	Conducted		
	channel	(MHz)	conducted	measured	common	power	Gain	TX power		
	(channel Index)	channel	Maximum TX	Conducted	conducted RF TX	conducted to	setting in	setting in FW		
		centre.	Power	Peak POWER	power setting	implement in	FW			
			setting dBm	(dBm)	across all 4 BLE	FW. Other				
					data rates.	restrictions (if				
DIE 114h	CH0 (CH37)	2402 MHz	20dBm	19.89dBm	20dBm	any). 17dBm	3.5dBi	20dBm		
BLE 1Mbps	CH39 (CH39)	2402 MHz	20dBm	17.23dBm	20dBm	17dBm	3.5dBi	20dBm		
BLE 2Mbps	CH39 (CH39)	2480 MHz	20dBm 20dBm	17.23dBm 19.91dBm	20dBm 20dBm	17dBm 17dBm	3.5dBi	20dBm 20dBm		
DEE ZIVIDOS	CH38 (CH36)	2404 MHz	20dBm	19.91dBM 19.79dBm	20dBm	17dBm	3.5dBi	20dBm		
BLE	CH38 (CH36)	2478 MHz	20dBm 20dBm	19.79dBm 19.88dBm	20dBm 20dBm	17dBm 17dBm	3.5dBi	20dBm 20dBm		
125kbps	CH39 (CH39)	2402 MHz	20dBm	19.880BM	20dBm	17dBm	3.5dBi	20dBm		
BLE	` ′	2480 MHz	20dBm 20dBm	19.25dBm 19.89dBm	20dBm 20dBm	17dBm 17dBm	3.5dBi	20dBm 20dBm		
500kbps	CH0 (CH37)	2402 MHz	20dBm 20dBm	19.89dBm 19.25dBm	20dBm 20dBm	17dBm 17dBm	3.5dBi	20dBm 20dBm		
Sookups	CH39 (CH39)	248U IVIHZ	ZUUBIII	19.25gRW	ZUUBIII	1/08/11	3.5UBI	2006111		

Table 37: 10dBm mode – South Korea Radio TX power table

10dBm mode. DTS.	CERTIFIED maxim	um conducted Ri	F TX power per B	LE PHY	CERTIFIED LOWEST COMMON RF TX power setting across BLE PHY's, other restrict	IMPLEMENTED in customer MUST i developed C-code AFH firmware mo	ustomers own N.	
	NOTE1		I	1	NOTE2	NOTE3	NOTE4A	NOTE4B
BLE PHY	Physical channel (channel Index)	Frequency (MHz) channel centre.	(MHz) conducted Measured channel Maximum TX Conducted centre. Power Peak POWER		Certified common conducted RF TX power setting across all 4 BLE data rates.	Target RF TX power conducted to implement in FW. Other restrictions (if any).	Antenna Gain setting in FW	TX power setting in FW
BLE 1Mbps	CH0 (CH37)	2402 MHz	10dBm		10dBm	7dBm	3.5dBi	10dBm
	CH39 (CH39)	2480 MHz	10dBm		10dBm	7dBm	3.5dBi	10dBm
BLE 2Mbps	CH1 (CH0)	2404 MHz	10dBm		10dBm	7dBm	3.5dBi	10dBm
	CH38 (CH36)	2478 MHz	10dBm		10dBm	7dBm	3.5dBi	10dBm
BLE	CH0 (CH37)	2402 MHz	10dBm		10dBm	7dBm	3.5dBi	10dBm
125kbps	CH39 (CH39)	2480 MHz	10dBm		10dBm	7dBm	3.5dBi	10dBm
BLE	CH0 (CH37)	2402 MHz	10dBm		10dBm	7dBm	3.5dBi	10dBm
500kbps	CH39 (CH39)	2480 MHz	10dBm		10dBm	7dBm	3.5dBi	10dBm

Hong Kong: +852-2762-4823



**NOTE1**: CERTIFIED maximum conducted RF TX power per BLE PHY in 20dBm mode or 10dBm mode tables. This is not what is implemented in AT firmware, this is what was certified only.

**NOTE2**: Certified Lowest common TX power setting across BLE PHY's. This lowest common TX power setting is stated since we do <u>not</u> use **per BLE** RF TX power setting in AT firmware, but same TX power setting across all 4 BLE PHY's.

**NOTE3**: IMPLEMENT in AT firmware **target** RF TX power conducted. This target actual implemented in AT firmware. For South Korea, this is the actual target 17dBm conducted (in 20dBm mode) and 7dBm conducted (in 10dBm mode). To implement that, NOTE4A defines what Antenna Gain setting MUST be used and NOTE4B defines what TX power setting MUST be used.

**NOTE4**: IMPLEMENTED in AT firmware (or MUST implement in customers own developed C-code) the Actual target RF TX power conducted:

NOTE4A: the Antenna Gain setting of 3.5dBi and

NOTE4B: the TX power setting to 20dBm (in 20dBm mode) and 10dBm (in 10dBm mode).

which results in:

Target Actual RF TX power (dBm) = TX power setting (dBm) - Antenna Gain setting(dBi)

17dBm = 20dBm - 3.5dBi 7dBm = 10dBm - 3.5dBi

# 13.2.9 Global (lowest common across certified countries) Radio RF TX power Table

Same as EU (CE) AND additionally BLE CH39 2480MHz turned OFF. Refer to Europe (CE), UK (UKCA), Australia (RCM, New Zealand (RCM) Radio RF TX power Table.

https://www.lairdconnect.com/



# 13.3 Maximum Regulatory Certified RF TX Power per Country - 453-00145 Lyra 24P - Bluetooth v5.4 PCB Module (20dBm) with **Integrated Antenna**

#### 13.3.1 For shipped AT firmware

AT firmware implements RF TX power settings per country highlighted below sections.

	Country	Global	EU	UK	USA	Canada	Australia	New Zealand	Japan	South Korea
AT FW	Region code	GL	EU	UK	US	CA	AU	NZ	JP	SK
AFH?	Turned on or off?	on	on	on	on	on	on	on	on	on
20dBm mode	Target TX power conducted	17dBm	17dBm	17dBm	17dBm	17dBm	17dBm	17dBm	17dBm	17dBm
	Antenna Gain setting. NOTE5	3.5dBi	3.5dBi	3.5dBi	3.5dBi	3.5dBi	3.5dBi	3.5dBi	3.5dBi	3.5dBi
	TX power <b>setting</b>	20dBm	20dBm	20dBm	20dBm	20dBm	20dBm	20dBm	20dBm	20dBm
	Turn off CH39 2480MHz?	no	no	no	no	no	no	no	no	no
10dBm mode	Target TX power conducted	7dBm	7dBm	7dBm	7dBm	7dBm	7dBm	7dBm	7dBm	7dBm
	Antenna Gain setting	3.5dBi	3.5dBi	3.5dBi	3.5dBi	3.5dBi	3.5dBi	3.5dBi	3.5dBi	3.5dBi
	TX power <b>setting</b>	10dBm	10dBm	10dBm	10dBm	10dBm	10dBm	10dBm	10dBm	10dBm

453-00145 Lyra 24P - Bluetooth v5.4 PCB Module (20dBm) with Integrated Antenna when loaded with AT firmware where the radio regulatory region "global" is set which is lowest common settings across RF TX power across certified countries. To switch to the specific radio regulatory region country of USA, Canada, Europe, UK, Australia, New Zealand, Japan and South Korea, customer can use appropriate AT command for setting the radio regulatory region per country.

#### 13.3.2 For customers C code development

Customers developing with C Code - Full software development with Silicon Labs SDK and Toolchain, MUST implement the maximum RF TX power settings per country and other parameters mentioned in this section.

#### 13.3.3 AFH firmware module description

See section AFH firmware module.

Americas: +1-800-492-2320 Europe: +44-1628-858-940

Hong Kong: +852-2762-4823



# 13.3.4 Europe (CE), UK (UKCA), Australia (RCM, New Zealand (RCM) Radio RF TX power Table

Table 38: 20dBm mode - Europe (CE), UK (UKCA), Australia (RCM, New Zealand (RCM) Radio TX power table

Module Lair	d Part number	453-00145								
Description		Lyra 24P - Blue	tooth v5.4 PCB M	odule (20dBm) w	vith integrated antenn	a (Silicon Labs EFR3:	2BG24)			
Antenna Gai	in (dBi)	1.82dBi peak								
Radio Regula	atory country:	Europe (CE), UI	K (UKCA), Austra	lia (RCM) and Ne	w Zealand (RCM)					
Declared as I	FHSS or DTS?	FHSS (uses Silal	os AFH FW modu	le ON)						
AFH FW mod	dule?	AFH firmware r	module turned Of	V.						
Silabs BLE SD	OK:	5.0.0.0 GA (Ded	cember 14, 2022)							
Silabs Gecko	SDK Suite:	4.2 (December 14, 2022).								
20dBm mode. FHSS.	CERTIFIED maxim	ium conducted R	F TX power per B	LE PHY	CERTIFIED LOWEST COMMON RF TX power setting across BLE PHY's, other restrict	IMPLEMENTED in Laird Connectivity AT FW customer MUST implement in customers ov developed C-code.  AFH firmware module turned ON.				
	NOTE1				NOTE2	NOTE3	NOTE4A	NOTE4B		
BLE PHY	Physical channel (channel Index)	Frequency (MHz) channel centre.	Certified conducted Maximum TX Power setting dBm	Certified measured Conducted Peak POWER (dBm)	Certified Lowest common conducted RF TX power setting across all 4 BLE data rates.	Target RF TX power conducted to implement in FW. Other restrictions (if any).	Antenna Gain setting in FW	Conducted TX power setting in FW		
BLE 1Mbps	CH0 (CH37)	2402 MHz	17dBm	17.41dBm	17dBm	17dBm	3.5dBi	20dBm		
	CH39 (CH39)	2480 MHz	17dBm	17.14 dBm	17dBm	17dBm	3.5dBi	20dBm		
BLE 2Mbps	CH1 (CH0)	2404 MHz	17dBm	17.44dBm	17dBm	17dBm	3.5dBi	20dBm		
	CH38 (CH36)	2478 MHz	17dBm	17.22dBm	17dBm	17dBm	3.5dBi	20dBm		
BLE	CH0 (CH37)	2402 MHz	17dBm	17.40dBm	17dBm	17dBm	3.5dBi	20dBm		
125kbps	CH39 (CH39)	2480 MHz	17dBm	17.10dBm	17dBm	17dBm	3.5dBi	20dBm		
BLE	CH0 (CH37)	2402 MHz	17dBm	17.40dBm	17dBm	17dBm	3.5dBi	20dBm		
500kbps	CH39 (CH39)	2480 MHz	17dBm	17.15dBm	17dBm	17dBm	3.5dBi	20dBm		

Table 39: 10dBm mode - Europe (CE), UK (UKCA), Australia (RCM, New Zealand (RCM) Radio TX power table

10dBm mode. DTS.		num conducted RF TX power per BLE PHY			CERTIFIED LOWEST COMMON RF TX power setting across BLE PHY's, other restrict	IMPLEMENTED in Laird Connectivity AT FW or customer MUST implement in customers own developed C-code.  AFH firmware module turned ON.		
	NOTE1			NOTE2	NOTE3	NOTE4A	NOTE4B	
BLE PHY	Physical channel (channel Index)	Frequency (MHz) channel centre.	Certified conducted Maximum TX Power setting dBm	Certified Measured Conducted Peak POWER (dBm)	Certified Lowest common conducted RF TX power setting across all 4 BLE data rates.	Target RF TX power conducted to implement in FW. Other restrictions (if any).	Antenna Gain setting in FW	TX power setting in FW
BLE 1Mbps	CH0 (CH37)	2402 MHz	7dBm	7.43dBm	7dBm	7dBm	3.5dBi	10dBm
	CH19 (CH17)	2440 MHz	8dBm	8.13dBm	7dBm	7dBm	3.5dBi	10dBm
	CH39 (CH39)	2480 MHz	8dBm	7.99dBm	7dBm	7dBm	3.5dBi	10dBm
BLE 2Mbps	CH1 (CH0)	2404 MHz	7dBm	7.44dBm	7dBm	7dBm	3.5dBi	10dBm
	CH19 (CH17)	2440 MHz	7dBm	7.27dBm	7dBm	7dBm	3.5dBi	10dBm
	CH38 (CH36)	2478 MHz	8dBm	8.03dBm	7dBm	7dBm	3.5dBi	10dBm
BLE	CH0 (CH37)	2402 MHz	7dBm	7.43dBm	7dBm	7dBm	3.5dBi	10dBm
125kbps	CH19 (CH17)	2440 MHz	8dBm	8.13dBm	7dBm	7dBm	3.5dBi	10dBm
	CH39 (CH39)	2480 MHz	8dBm	7.98dBm	7dBm	7dBm	3.5dBi	10dBm
BLE	CH0 (CH37)	2402 MHz	7dBm	7.43dBm	7dBm	7dBm	3.5dBi	10dBm
500kbps	CH19 (CH17)	2440 MHz	8dBm	8.13dBm	7dBm	7dBm	3.5dBi	10dBm
	CH39 (CH39)	2480 MHz	8dBm	7.99dBm	7dBm	7dBm	3.5dBi	10dBm



Each column of the table has NOTE reference and these NOTES are:

**NOTE1**: CERTIFIED maximum conducted RF TX power per BLE PHY in 20dBm mode or 10dBm mode tables. This is not what is implemented in AT firmware, this is what was certified only.

**NOTE2**: Certified Lowest common TX power setting across BLE PHY's. This lowest common TX power setting is stated since we do not use **per BLE** RF TX power setting in AT firmware, but same TX power setting across all 4 BLE PHY's.

**NOTE3**: IMPLEMENT in AT firmware **target** RF TX power conducted. This target actual implemented in AT firmware. So for CE, UKCA, RCM (Australia and New Zealand), this is actual target 17dBm conducted (in 20dBm mode) and 7dBm conducted (in 10dBm mode). To implement that, NOTE4A defines what Antenna Gain setting MUST be used and NOTE4B defines what TX power setting MUST be used.

**NOTE4**: IMPLEMENTED in AT firmware (or MUST implement in customers own developed C-code) the Actual target RF TX power conducted:-

NOTE4A: the Antenna Gain setting of 3.5dBi and

NOTE4B: the TX power setting to 20dBm (in 20dBm mode) and 10dBm (in 10dBm mode).

which results in:

Target Actual RF TX power (dBm) = TX power setting (dBm) - Antenna Gain setting(dBi)

17dBm = 20dBm - 3.5dBi 7dBm = 10dBm - 3.5dBi



# 13.3.5 USA (FCC), Canada (ISED) Radio RF TX power Table

#### Table 40: 20dBm mode - Usa (FCC), Canada (ISED) Radio TX power table

Module Laird Part number		453-00145								
Description		Lyra 24P - Bluetooth v5.4 PCB Module (20dBm) with integrated antenna (Silicon Labs EFR32BG24)								
Antenna Gain (dBi)		1.82dBi peak								
Radio Regulatory country:		USA (FCC), CANADA (ISED)								
Declared as FHSS or DTS?		FHSS (uses Silabs AFH FW module ON)								
AFH FW module?		AFH firmware module turned ON.								
Silabs BLE SDK:		5.0.0.0 GA (December 14, 2022).								
Silabs Gecko SDK Suite:		4.2 (December 14, 2022).								
20dBm mode. FHSS.	CERTIFIED maximum conducted RF TX power per BLE PHY				CERTIFIED LOWEST COMMON RF TX power setting across BLE PHY's, other restrict	IMPLEMENTED in Laird Connectivity AT FW or customer MUST implement in customers own developed C-code.  AFH firmware module turned ON.				
	NOTE1				NOTE2	NOTE3	NOTE4A	NOTE4B		
BLE PHY	Physical	Frequency	Certified	Certified	Certified Lowest	Target RF TX	Antenna	TX power		
	channel	(MHz)	conducted	Measured	common	power	Gain	setting in FW		
	(channel Index)	channel	Maximum TX	Conducted	conducted RF TX	conducted to	setting in			
		centre.	Power	Peak POWER	power setting	implement in	FW			
			setting dBm	(dBm)	across all 4 BLE	FW. Other				
					data rates.	restrictions (if any).				
BLE 1Mbps	CH0 (CH37)	2402 MHz	20dBm	19.63dBm	20dBm	17dBm	3.5dBi	20dBm		
	CH39 (CH39)	2480 MHz	20dBm	17.12dBm	20dBm	17dBm	3.5dBi	20dBm		
BLE 2Mbps	CH1 (CH0)	2404 MHz	20dBm	19.62dBm	20dBm	17dBm	3.5dBi	20dBm		
	CH38 (CH36)	2478 MHz	20dBm	19.45dBm	20dBm	17dBm	3.5dBi	20dBm		
BLE	CH0 (CH37)	2402 MHz	20dBm	19.62dBm	20dBm	17dBm	3.5dBi	20dBm		
125kbps	CH39 (CH39)	2480 MHz	20dBm	19.23dBm	20dBm	17dBm	3.5dBi	20dBm		
BLE	CH0 (CH37)	2402 MHz	20dBm	19.61dBm	20dBm	17dBm	3.5dBi	20dBm		
500kbps	CH39 (CH39)	2480 MHz	20dBm	19.22dBm	20dBm	17dBm	3.5dBi	20dBm		

Table 41: 10dBm mode - Usa (FCC), Canada (ISED) Radio TX power table

10dBm mode. DTS.	CERTIFIED maximum conducted RF TX power per BLE PHY				CERTIFIED LOWEST COMMON RF TX power setting across BLE PHY's, other restrict	Implemented in Laird Connectivity AT FW or customer MUST implement in customers own developed C-code.		
	NOTE1			NOTE2	NOTE3	NOTE4A	NOTE4B	
BLE PHY	Physical channel (channel Index)	Frequency (MHz) channel centre.	Certified conducted Maximum TX Power setting dBm	Certified Measured Conducted Peak POWER (dBm)	Certified Lowest common conducted RF TX power setting across all 4 BLE data rates.	Target RF TX power conducted to implement in FW. Other restrictions (if any).	Antenna Gain setting in FW	TX power setting in FW
BLE 1Mbps	CH0 (CH37)	2402 MHz	10dBm	9.83dBm	10dBm	7dBm	3.5dBi	10dBm
	CH39 (CH39)	2480 MHz	10dBm	9.31dBm	10dBm	7dBm	3.5dBi	10dBm
BLE 2Mbps	CH1 (CH0)	2404 MHz	10dBm	9.82dBm	10dBm	7dBm	3.5dBi	10dBm
	CH38 (CH36)	2478 MHz	10dBm	9.30dBm	10dBm	7dBm	3.5dBi	10dBm
BLE	CH0 (CH37)	2402 MHz	10dBm	9.81dBm	10dBm	7dBm	3.5dBi	10dBm
125kbps	CH39 (CH39)	2480 MHz	10dBm	9.47dBm	10dBm	7dBm	3.5dBi	10dBm
BLE	CH0 (CH37)	2402 MHz	10dBm	9.79dBm	10dBm	7dBm	3.5dBi	10dBm
500kbps	CH39 (CH39)	2480 MHz	10dBm	9.28dBm	10dBm	7dBm	3.5dBi	10dBm



**NOTE1**: CERTIFIED maximum conducted RF TX power per BLE PHY in 20dBm mode or 10dBm mode tables. This is not what is implemented in AT firmware, this is what was certified only.

**NOTE2**: Certified Lowest common TX power setting across BLE PHY's **is 17dBm AND BLE CH39 2480MHz** is **turned OFF**. Why do we turn OFF BLE CH39 2480MHz is because the CH39 2480MHz RF TX power that FCC, ISED pass was achieved at 15dBm, which is lower than 17dBm achieved at some of the other BLE channels. So, to use the lowest common RF TX power setting of 17dBm AND MUST turn OFF BLE channel CH39 2480MHz.

**NOTE3**: IMPLEMENT in AT firmware **target** RF TX power conducted. This target actual implemented in AT firmware. So for FCC (USA), ISED (Canada), this is actual 17dBm conducted (in 20dBm mode) and 7dBm conducted (in 10dBm mode). To implement that, NOTE4A defines what Antenna Gain setting MUST be used and NOTE4B defines what TX power setting MUST be used.

**NOTE4**: IMPLEMENTED in AT firmware (or MUST implement in customers own developed C-code) the Actual target RF TX power conducted:-

NOTE4A: the Antenna Gain setting of 3.5dBi and

NOTE4B: the TX power setting to 20dBm (in 20dBm mode) and 10dBm (in 10dBm mode).

which results in:

Target Actual RF TX power (dBm) = TX power setting (dBm) - Antenna Gain setting(dBi)

17dBm = 20dBm - 3.5dBi7dBm = 10dBm - 3.5dBi



## 13.3.6 Japan (MIC) Radio RF TX power Table

Table 42: 20dBm mode - Japan (MIC) Radio TX power table

Module Lair	d Part number	453-00145								
Description		Lyra 24P - Blue	tooth v5.4 PCB M	lodule (20dBm) w	rith integrated antenn	a (Silicon Labs EFR32	2BG24)			
Antenna Gai	n (dBi)	1.82dBi peak								
Radio Regula	atory country:	Japan (MIC)								
Declared as	FHSS or DTS?	FHSS (uses Silal	FHSS (uses Silabs AFH FW module ON)							
AFH FW mod	dule?	AFH firmware module turned ON.								
Silabs BLE SE	OK:	5.0.0.0 GA (Dec	cember 14, 2022)							
Silabs Gecko	SDK Suite:	4.2 (December	14, 2022).							
20dBm	CERTIFIED maxim	um conducted R	F TX power per B	LE PHY	CERTIFIED	IMPLEMENTED in	Laird Connect	ivity AT FW or		
mode.					LOWEST	customer MUST i	mplement in c	ustomers own		
FHSS.					COMMON RF TX	developed C-code	e.			
					power setting	AFH firmware mo	odule turned O	N.		
					across BLE PHY's, other restrict					
							1	1		
	NOTE1			_	NOTE2	NOTE3	NOTE4A	NOTE4B		
BLE PHY	Physical	Frequency	Certified	Certified	Certified Lowest	Target RF TX	Antenna	TX power		
	channel	(MHz)	conducted	Measured	common	power	Gain	setting in FW		
	(channel Index)	channel	Maximum TX	Conducted	conducted RF TX	conducted to	setting in			
		centre.	Power	Peak POWER	power setting	implement in	FW			
			setting dBm	(dBm)	across all 4 BLE	FW. Other				
					data rates.	restrictions (if				
D. 5 4 4 4	0110 (01107)	2402 1411	40.10	10.10.10	40.10	any).	0.5.15:	20.15		
BLE 1Mbps	CH0 (CH37)	2402 MHz	18dBm	18.19dBm	18dBm	17dBm	3.5dBi	20dBm		
DIE 2MAh.	CH39 (CH39)	2480 MHz	20dBm	17.66dBm	18dBm	17dBm	3.5dBi	20dBm		
BLE 2Mbps	CH1 (CH0)	2404 MHz	18dBm	18.16dBm	18dBm	17dBm	3.5dBi	20dBm		
DI E	CH38 (CH36)	2478 MHz	18dBm	18.05dBm	18dBm	17dBm	3.5dBi	20dBm		
BLE	CH0 (CH37)	2402 MHz	18dBm	18.12dBm	18dBm	17dBm	3.5dBi	20dBm		
125kbps	CH39 (CH39)	2480 MHz	18dBm	17.96dBm	18dBm	17dBm	3.5dBi	20dBm		
BLE	CH0 (CH37)	2402 MHz	18dBm	18.12dBm	18dBm	17dBm	3.5dBi	20dBm		
500kbps	CH39 (CH39)	2480 MHz	18dBm	17.95dBm	18dBm	17dBm	3.5dBi	20dBm		

Table 43: 10dBm mode - Japan (MIC) Radio TX power table

10dBm mode. DTS.	CERTIFIED maximum conducted RF TX power per BLE PHY				CERTIFIED LOWEST COMMON RF TX power setting across BLE PHY's, other restrict	Implemented in L customer MUST i developed C-code	mplement in c	-
	NOTE1				NOTE2	NOTE3	NOTE4A	NOTE4B
BLE PHY	Physical channel (channel Index)	Frequency (MHz) channel centre.	Certified conducted Maximum TX Power setting dBm	Certified Measured Conducted Peak POWER (dBm)	Certified Lowest common conducted RF TX power setting across all 4 BLE data rates.	Target RF TX power conducted to implement in FW. Other restrictions (if any).	Antenna Gain setting in FW	TX power setting in FW
BLE 1Mbps	CH0 (CH37)	2402 MHz	10dBm	9.65dBm	10dBm	7dBm	3.5dBi	10dBm
	CH39 (CH39)	2480 MHz	10dBm	9.43dBm	10dBm	7dBm	3.5dBi	10dBm
BLE 2Mbps	CH1 (CH0)	2404 MHz	10dBm	9.63dBm	10dBm	7dBm	3.5dBi	10dBm
	CH38 (CH36)	2478 MHz	10dBm	9.44dBm	10dBm	7dBm	3.5dBi	10dBm
BLE	CH0 (CH37)	2402 MHz	10dBm	9.62dBm	10dBm	7dBm	3.5dBi	10dBm
125kbps	CH39 (CH39)	2480 MHz	10dBm	9.42dBm	10dBm	7dBm	3.5dBi	10dBm
BLE	CH0 (CH37)	2402 MHz	10dBm	9.64dBm	10dBm	7dBm	3.5dBi	10dBm
500kbps	CH39 (CH39)	2480 MHz	10dBm	9.45dBm	10dBm	7dBm	3.5dBi	10dBm



**NOTE1**: CERTIFIED maximum conducted RF TX power per BLE PHY in 20dBm mode or 10dBm mode tables. This is not what is implemented in AT firmware, this is what was certified only.

**NOTE2**: Certified Lowest common TX power setting across BLE PHY's. This lowest common TX power setting is stated since we do <u>not</u> use **per BLE** RF TX power setting in AT firmware, but same TX power setting across all 4 BLE PHY's.

**NOTE3**: IMPLEMENT in AT firmware **target** RF TX power conducted. This target actual implemented in AT firmware. So for Japan, this is the actual target 17dBm conducted (in 20dBm mode) and 7dBm conducted (in 10dBm mode). To implement that, NOTE4A defines what Antenna Gain setting MUST be used and NOTE4B defines what TX power setting MUST be used.

**NOTE4**: IMPLEMENTED in AT firmware (or MUST implement in customers own developed C-code) the Actual target RF TX power conducted:-

NOTE4A: the Antenna Gain setting of 3.5dBi and

NOTE4B: the TX power setting to 20dBm (in 20dBm mode) and 10dBm (in 10dBm mode).

which results in:

Target Actual RF TX power (dBm) = TX power setting (dBm) - Antenna Gain setting(dBi)

17dBm = 20dBm - 3.5dBi7dBm = 10dBm - 3.5dBi



## 13.3.7 South Korea Radio RF TX power Table

Table 44: 20dBm mode – South Korea Radio TX power table

Module Lair	d Part number	453-00145									
Description		Lyra 24P - Bluet	tooth v5.4 PCB M	odule (20dBm) w	rith integrated antenna	a (Silicon Labs EFR3:	2BG24)				
Antenna Gai	n (dBi)	1.82dBi peak									
Radio Regula	atory country:	South Korea									
Declared as I	HSS or DTS?	FHSS (uses Silal	FHSS (uses Silabs AFH FW module ON)								
AFH FW mod	lule?	AFH firmware r	AFH firmware module turned ON.								
Silabs BLE SD	K:	5.0.0.0 GA (Dec	ember 14, 2022)								
Silabs Gecko	SDK Suite:	4.2 (December	14, 2022).								
20dBm	CERTIFIED mayim	aandustad D	T TV manuar mar D	I F DIIV	CERTIFIED	INADI ENAFAITED :	Laird Connact	inite AT FIA/ au			
mode.	CERTIFIED maxim	ium conducted K	r ix power per B	LEPHI	LOWEST	IMPLEMENTED in customer MUST i					
FHSS.					COMMON RF TX	developed C-code	-	ustomers own			
11133.					power setting	AFH firmware mo		N.			
					across BLE PHY's,						
					other restrict						
	NOTE1				NOTE2	NOTE3	NOTE4A	NOTE4B			
BLE PHY	Physical	Frequency	Certified	Certified	Certified Lowest	Target RF TX	Antenna	TX power			
	channel	(MHz)	conducted	Measured	common	power	Gain	setting in FW			
	(channel Index)	channel	Maximum TX	Conducted	conducted RF TX	conducted to	setting in				
		centre.	Power	Peak POWER	power setting	implement in	FW				
			setting dBm	(dBm)	across all 4 BLE	FW. Other					
					data rates.	restrictions (if					
515444	0110 (01107)	2402 144	20.10	40.00 10	20.10	any).	0.5.15:	20.15			
BLE 1Mbps	CH0 (CH37)	2402 MHz	20dBm	19.22dBm	20dBm	17dBm	3.5dBi	20dBm			
DIE 2Mbras	CH39 (CH39)	2480 MHz 2404 MHz	20dBm 20dBm	16.77dBm 19.28dBm	20dBm 20dBm	17dBm 17dBm	3.5dBi 3.5dBi	20dBm 20dBm			
BLE 2Mbps	CH1 (CH0)	2404 MHz	20dBm 20dBm	19.28dBm 19.26dBm	20dBm 20dBm	17dBm 17dBm		20dBm 20dBm			
BLE	CH38 (CH36) CH0 (CH37)	24/8 MHz	20dBm 20dBm	19.26dBm 19.27dBm	20dBm 20dBm	17dBm 17dBm	3.5dBi 3.5dBi	20dBm 20dBm			
125kbps	, ,	2402 MHz	20dBm 20dBm	19.27dBm 18.73dBm	20dBm 20dBm	17dBm 17dBm	3.5dBi	20dBm 20dBm			
BLE	CH39 (CH39)	2480 MHz	20dBm 20dBm	19.26dBm	20dBm 20dBm	17dBm 17dBm	3.5dBi	20dBm 20dBm			
500kbps	CH0 (CH37)										
зоокарѕ	CH39 (CH39)	2480 MHz	20dBm	18.76dBm	20dBm	17dBm	3.5dBi	20dBm			

Table 45: 10dBm mode – South Korea Radio TX power table

10dBm mode. DTS.		ERTIFIED maximum conducted RF TX power per BLE PHY				Implemented in Laird Connectivity AT FW or customer MUST implement in customers own developed C-code.		
	NOTE1				NOTE2	NOTE3	NOTE4A	NOTE4B
BLE PHY	Physical channel (channel Index)	Frequency (MHz) channel centre.	Certified conducted Maximum TX Power setting dBm	Certified Measured Conducted Peak POWER (dBm)	Certified Lowest common conducted RF TX power setting across all 4 BLE data rates.	Target RF TX power conducted to implement in FW. Other restrictions (if any).	Antenna Gain setting in FW	TX power setting in FW
BLE 1Mbps	CH0 (CH37)	2402 MHz	10dBm		10dBm	7dBm	3.5dBi	10dBm
	CH39 (CH39)	2480 MHz	10dBm		10dBm	7dBm	3.5dBi	10dBm
BLE 2Mbps	CH1 (CH0)	2404 MHz	10dBm		10dBm	7dBm	3.5dBi	10dBm
	CH38 (CH36)	2478 MHz	10dBm		10dBm	7dBm	3.5dBi	10dBm
BLE	CH0 (CH37)	2402 MHz	10dBm		10dBm	7dBm	3.5dBi	10dBm
125kbps	CH39 (CH39)	2480 MHz	10dBm		10dBm	7dBm	3.5dBi	10dBm
BLE	CH0 (CH37)	2402 MHz	10dBm		10dBm	7dBm	3.5dBi	10dBm
500kbps	CH39 (CH39)	2480 MHz	10dBm		10dBm	7dBm	3.5dBi	10dBm



**NOTE1**: CERTIFIED maximum conducted RF TX power per BLE PHY in 20dBm mode or 10dBm mode tables. This is not what is implemented in AT firmware, this is what was certified only.

**NOTE2**: Certified Lowest common TX power setting across BLE PHY's. This lowest common TX power setting is stated since we do <u>not</u> use **per BLE** RF TX power setting in AT firmware, but same TX power setting across all 4 BLE PHY's.

**NOTE3**: IMPLEMENT in AT firmware **target** RF TX power conducted. This target actual implemented in AT firmware. So for South Korea, this is the actual target 17dBm conducted (in 20dBm mode) and 7dBm conducted (in 10dBm mode). To implement that, NOTE4A defines what Antenna Gain setting MUST be used and NOTE4B defines what TX power setting MUST be used.

**NOTE4**: IMPLEMENTED in AT firmware (or MUST implement in customers own developed C-code) the Actual target RF TX power conducted:-

NOTE4A: the Antenna Gain setting of 3.5dBi and

NOTE4B: the TX power setting to 20dBm (in 20dBm mode) and 10dBm (in 10dBm mode).

which results in:

Target Actual RF TX power (dBm) = TX power setting (dBm) - Antenna Gain setting(dBi)

17dBm = 20dBm - 3.5dBi7dBm = 10dBm - 3.5dBi

## 13.3.8 Global (lowest common across certified countries) Radio RF TX power Table

Same as EU (CE). Refer to Europe (CE), UK (UKCA), Australia (RCM, New Zealand (RCM) Radio RF TX power Table.

https://www.lairdconnect.com/

Americas: +1-800-492-2320 Europe: +44-1628-858-940 Hong Kong: +852-2762-4823



## 13.4Maximum Regulatory Certified RF TX Power per Country – 453-00184 Lyra 24P – Bluetooth v5.4 USB Adaptor (20dBm) with Integrated Antenna

The Lyra 24P USB adaptor uses the 453-000145 - Lyra 24P Series - Bluetooth v5.4 PCB Module (20dBm) with integrated antenna module. The maximum regulatory certified TX power per country for the 453-00184 Lyra 24P - Bluetooth v5.4 USB Adaptor with Integrated Antenna is the same as the Maximum Regulatory Certified RF TX Power per Country - 453-00145 Lyra 24P - Bluetooth v5.4 PCB Module (20dBm) with Integrated Antenna.

The certifications for the Lyra 24 USB Adaptor are performed with the DCDC converter turned on only.



## 13.5 Maximum Regulatory Certified RF TX Power per Country – 453-00142 Lyra 24P – Bluetooth v5.4 PCB Module (10dBm) with Integrated Antenna

#### 13.5.1 For shipped AT firmware

Laird Connectivity AT firmware implements maximum RF TX power settings per country highlighted below.

	Country	Global	EU	UK	USA	Canada	Australia	New Zealand	Japan	South Korea
AT FW	Region code	GL	EU	UK	US	CA	AU	NZ	JP	SK
AFH?	Turned on or off	off	off	off	off	off	off	off	off	off
10dBm mode	Target TX power conducted	7dBm	7dBm	7dBm	10dBm	10dBm	7dBm	7dBm	9dBm	10dBm
	Antenna Gain setting	0dBi	0dBi	0dBi	0dBi	0dBi	0dBi	0dBi	0dBi	0dBi
	TX power <b>setting</b>	7dBm	7dBm	7dBm	10dBm	10dBm	7dBm	7dBm	9dBm	10dBm

453-00142 Lyra 24P – Bluetooth v5.4 PCB Module (10dBm) with Integrated Antenna is shipped AT firmware where the radio regulatory region "global" is set which is lowest common settings across RF TX power across certified countries. To switch to the specific radio regulatory region country of USA, Canada, Europe, UK, Australia, New Zealand, Japan and South Korea, customer can use appropriate AT command for setting the radio regulatory region per country.

#### 13.5.2 For customers C code development

Customers developing with **C Code** – Full software development with Silicon Labs SDK and Toolchain, MUST implement the maximum RF TX power settings per country and other parameters mentioned in this section.

#### 13.5.3 AFH firmware module description

See section AFH firmware module.

https://www.lairdconnect.com/

**Europe**: +44-1628-858-940 **Hong Kong**: +852-2762-4823

Americas: +1-800-492-2320



## 13.5.4 Europe (CE), UK (UKCA), Australia (RCM, New Zealand (RCM) Radio RF TX power Table

Table 46: Europe (CE), UK (UKCA), Australia (RCM, New Zealand (RCM) Radio TX power table

Module Lair	d Part number	453-00142								
Description		Lyra 24P - Blue	tooth v5.4 PCB M	lodule (10dBm) w	rith integrated antenn	a (Silicon Labs EFR3	2BG24)			
Antenna Gai	n (dBi)	1.82dBi peak								
Radio Regula	atory country:	Europe (CE), U	Europe (CE), UK (UKCA), Australia (RCM) and New Zealand (RCM)							
Declared as I	HSS or DTS?	DTS (uses Silab	DTS (uses Silabs AFH FW module ON to cover Adaptivity test)							
AFH FW mod	lule?	AFH firmware i	module turned OI	N.						
Silabs BLE SE	K:	5.0.0.0 GA (Ded	cember 14, 2022)							
Silabs Gecko	SDK Suite:	4.2 (December	r 14, 2022).							
10dBm CERTIFIED maximum conducted RF TX power per BLE PHY				CERTIFIED LOWEST COMMON RF TX power setting across BLE PHY's, other restrict	IMPLEMENTED in Laird Connectivity AT FW or customer MUST implement in customers own developed C-code. AFH firmware module turned ON.					
	NOTE1					NOTE3	NOTE4A	NOTE4B		
BLE PHY	Physical channel (channel Index)	Frequency (MHz) channel centre.	Certified conducted Maximum TX Power setting dBm	Certified measured Conducted Peak POWER (dBm)	Certified Lowest common conducted RF TX power setting across all 4 BLE data rates.	Target RF TX power conducted to implement in FW. Other restrictions (if any).	Antenna Gain setting in FW	Conducted TX power setting in FW		
BLE 1Mbps	CH0 (CH37)	2402 MHz	7dBm	7.75dBm	7dBm	7dBm	0dBi	7dBm		
	CH39 (CH39)	2480 MHz	7dBm	7.66dBm	7dBm	7dBm	0dBi	7dBm		
BLE 2Mbps	CH1 (CH0)	2404 MHz	7dBm	7.76dBm	7dBm	7dBm	0dBi	7dBm		
	CH38 (CH36)	2478 MHz	7dBm	7.68dBm	7dBm	7dBm	0dBi	7dBm		
BLE	CH0 (CH37)	2402 MHz	7dBm	7.75dBm	7dBm	7dBm	0dBi	7dBm		
125kbps	CH39 (CH39)	2480 MHz	7dBm	7.66dBm	7dBm	7dBm	0dBi	7dBm		
BLE	CH0 (CH37)	2402 MHz	7dBm	7.75dBm	7dBm	7dBm	0dBi	7dBm		
500kbps	CH39 (CH39)	2480 MHz	7dBm	7.67dBm	7dBm	7dBm	0dBi	7dBm		

**NOTE1**: CERTIFIED maximum conducted RF TX power per BLE PHY. This is not what is implemented in AT firmware, this is what was certified only.

**NOTE2**: Certified Lowest common TX power setting across BLE PHY's. This lowest common TX power setting is stated since we do not use **per BLE** RF TX power setting in AT firmware, but same TX power setting across all 4 BLE PHY's.

**NOTE3**: IMPLEMENT in AT firmware **target** RF TX power conducted. This target actual implemented in AT firmware. So for CE, UKCA, RCM (Australia and New Zealand), this is actual target 7dBm conducted. To implement that, NOTE4A defines what Antenna Gain setting MUST be used and NOTE4B defines what TX power setting MUST be used.

**NOTE4**: IMPLEMENTED in AT firmware (or MUST implement in customers own developed C-code) the Actual target RF TX power conducted:-

NOTE4A: the Antenna Gain setting of 0dBi and

NOTE4B: the TX power setting to 7dBm.

which results in:

Target Actual RF TX power (dBm) = TX power setting (dBm) - Antenna Gain setting(dBi)

7dBm = 7dBm - 0dBi

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#### 13.5.5 USA (FCC), Canada (ISED) Radio RF TX power Table

#### Table 47: Usa (FCC), Canada (ISED) Radio TX power table

Module Lair	d Part number	453-00142						
Description		Lyra 24P - Bluet	tooth v5.4 PCB M	odule (10dBm) w	rith integrated antenn	a (Silicon Labs EFR3)	2BG24)	
Antenna Gai	n (dBi)	1.82dBi peak						
Radio Regula	atory country:	USA (FCC), Can	ada (ISED)					
Declared as I	HSS or DTS?	DTS ( Silabs AFI	H FW module OFF	-)				
AFH FW mod	lule?	AFH firmware r	nodule turned Of	F.				
Silabs BLE SD	K:	5.0.0.0 GA (Dec	ember 14, 2022)					
Silabs Gecko	SDK Suite:	4.2 (December	14, 2022).					
10dBm CERTIFIED maximum conducted RF TX power per BLE PHY					CERTIFIED LOWEST COMMON RF TX power setting across BLE PHY's, other restrict	IMPLEMENTED in Laird Connectivity AT FW or customer MUST implement in customers own developed C-code.  AFH firmware module turned ON.		
	NOTE1				NOTE2	NOTE3	NOTE4A	NOTE4B
BLE PHY	Physical	Frequency	Certified	Certified	Certified Lowest	Target RF TX	Antenna	Conducted
	channel	(MHz)	conducted	measured	common	power	Gain	TX power
	(channel Index)	channel	Maximum TX	Conducted	conducted RF TX	conducted to	setting in	setting in FW
		centre.	Power	Peak POWER	power setting	implement in	FW	
			setting dBm	(dBm)	across all 4 BLE	FW. Other		
					data rates.	restrictions (if any).		
BLE 1Mbps	CH0 (CH37)	2402 MHz	10dBm	9.91dBm	10dBm	10dBm	OdBi	10dBm
DLL INIDPS	CH39 (CH39)	2480 MHz	10dBm	9.74dBm	10dBm	10dBm	OdBi	10dBm
BLE 2Mbps	CH1 (CH0)	2404 MHz	10dBm	9.90dBm	10dBm	10dBm	0dBi	10dBm
222 2.41003	CH38 (CH36)	2478 MHz	10dBm	9.74dBm	10dBm	10dBm	OdBi	10dBm
BLE	CH0 (CH37)	2402 MHz	10dBm	9.89dBm	10dBm	10dBm	OdBi	10dBm
125kbps	CH39 (CH39)	2480 MHz	10dBm	9.73dBm	10dBm	10dBm	OdBi	10dBm
BLE	CH0 (CH37)	2402 MHz	10dBm	9.89dBm	10dBm	10dBm	OdBi	10dBm
500kbps	CH39 (CH39)	2480 MHz	10dBm	9.72dBm	10dBm	10dBm	OdBi	10dBm

NOTE1: CERTIFIED maximum conducted RF TX power per BLE PHY. This is not what is implemented in AT firmware, this is what was certified only.

NOTE2: Certified Lowest common TX power setting across BLE PHY's. This lowest common TX power setting is stated since we do not use per BLE RF TX power setting in AT firmware, but same TX power setting across all 4 BLE PHY's.

NOTE3: IMPLEMENT in AT firmware target RF TX power conducted. This target actual implemented in AT firmware. So for FCC, ISED, this is actual target 7dBm conducted. To implement that, NOTE4A defines what Antenna Gain setting MUST be used and NOTE4B defines what TX power setting MUST be used.

NOTE4: IMPLEMENTED in AT firmware (or MUST implement in customers own developed C-code) the Actual target RF TX power conducted:-

NOTE4A: the Antenna Gain setting of 0dBi and

NOTE4B: the TX power setting to 7dBm.

which results in:

Target Actual RF TX power (dBm) = TX power setting (dBm) - Antenna Gain setting(dBi)

7dBm = 7dBm - 0dBi

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### 13.5.6 Japan (MIC) Radio RF TX power Table

#### Table 48: Japan (MIC) Radio TX power table

Nondala Lain	dule Laird Part number 453-00142									
	a Part number	453-00142		- d. d - (10 d D)	ith interpretation	- (C:l: L-b- FFD2:	20.024)			
Description	(150)		tooth V5.4 PCB IVI	odule (10dBm) w	vith integrated antenn	a (Silicon Labs EFR3.	2BG24)			
Antenna Gai		1.82dBi peak								
	atory country:	Japan (MIC)								
	HSS or DTS?	· · · · · · · · · · · · · · · · · · ·	DTS ( Silabs AFH FW module OFF)							
AFH FW mod			AFH firmware module turned OFF.							
Silabs BLE SD		,	ember 14, 2022)							
Silabs Gecko	SDK Suite:	4.2 (December	14, 2022).							
10dBm	CERTIFIED maxim	um conducted R	F TX power per B	LE PHY	CERTIFIED LOWEST COMMON RF TX power setting across BLE PHY's, other restrict	IMPLEMENTED in Laird Connectivity AT FW or customer MUST implement in customers own developed C-code.  AFH firmware module turned ON.				
	NOTE1				NOTE2	NOTE3	NOTE4A	NOTE4B		
BLE PHY	Physical	Frequency	Certified	Certified	Certified Lowest	Target RF TX	Antenna	Conducted		
	channel	(MHz)	conducted	measured	common	power	Gain	TX power		
	(channel Index)	channel	Maximum TX	Conducted	conducted RF TX	conducted to	setting in	setting in FW		
		centre.	Power	Peak POWER	power setting	implement in	FW			
			setting dBm	(dBm)	across all 4 BLE data rates.	FW. Other restrictions (if any).				
BLE 1Mbps	CH0 (CH37)	2402 MHz	9dBm	8.63dBm	9dBm	9dBm	OdBi	9dBm		
	CH39 (CH39)	2480 MHz	9dBm	8.49dBm	9dBm	9dBm	0dBi	9dBm		
BLE 2Mbps	CH1 (CH0)	2404 MHz	9dBm	8.55dBm	9dBm	9dBm	0dBi	9dBm		
	CH38 (CH36)	2478 MHz	9dBm	8.41dBm	9dBm	9dBm	0dBi	9dBm		
BLE	CH0 (CH37)	2402 MHz	9dBm	8.69dBm	9dBm	9dBm	0dBi	9dBm		
125kbps	CH39 (CH39)	2480 MHz	9dBm	8.56dBm	9dBm	9dBm	OdBi	9dBm		
BLE	CH0 (CH37)	2402 MHz	9dBm	8.61dBm	9dBm	9dBm	0dBi	9dBm		
500kbps	CH39 (CH39)	2480 MHz	9dBm	8.50dBm	9dBm	9dBm	0dBi	9dBm		

**NOTE1**: CERTIFIED maximum conducted RF TX power per BLE PHY. This is not what is implemented in AT firmware, this is what was certified only.

**NOTE2**: Certified Lowest common TX power setting across BLE PHY's. This lowest common TX power setting is stated since we do <u>not</u> use **per BLE** RF TX power setting in AT firmware, but same TX power setting across all 4 BLE PHY's.

**NOTE3**: IMPLEMENT in AT firmware **target** RF TX power conducted. This target actual implemented in AT firmware. So for Japan (MIC), this is actual target 7dBm conducted. To implement that, NOTE4A defines what Antenna Gain setting MUST be used and NOTE4B defines what TX power setting MUST be used.

**NOTE4**: IMPLEMENTED in AT firmware (or MUST implement in customers own developed C-code) the Actual target RF TX power conducted:-

NOTE4A: the Antenna Gain setting of 0dBi and

NOTE4B: the TX power setting to 7dBm.

which results in:

Target Actual RF TX power (dBm) = TX power setting (dBm) - Antenna Gain setting(dBi)

7dBm = 7dBm - 0dBi

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### 13.5.7 South Korea Radio RF TX power Table

#### Table 49: South Korea TX power table

	Part number	453-00142								
Description		Lyra 24P - Bluet	tooth v5.4 PCB M	odule (10dBm) w	rith integrated antenn	a (Silicon Labs EFR3)	2BG24)			
Antenna Gair	n (dBi)	1.82dBi peak								
Radio Regula	tory country:	South Korea	South Korea							
Declared as F	HSS or DTS?	FHSS (Silabs AF	FHSS (Silabs AFH FW module ON)							
AFH FW mod	ule?	AFH firmware r	nodule turned Of	٧.						
Silabs BLE SD	K:	5.0.0.0 GA (Dec	ember 14, 2022)							
Silabs Gecko	SDK Suite:	4.2 (December	14, 2022).							
10dBm	CERTIFIED maximum conducted RF TX power per BLE PHY				CERTIFIED LOWEST COMMON RF TX power setting across BLE PHY's, other restrict	IMPLEMENTED in Laird Connectivity AT FW or customer MUST implement in customers own developed C-code.  AFH firmware module turned ON.				
	NOTE1	I	I	T	NOTE2	NOTE3	NOTE4A	NOTE4B		
BLE PHY	Physical channel (channel Index)	Frequency (MHz) channel centre.	Certified conducted Maximum TX Power setting dBm	Certified measured Conducted Peak POWER (dBm)	Certified Lowest common conducted RF TX power setting across all 4 BLE data rates.	Target RF TX power conducted to implement in FW. Other restrictions (if any).	Antenna Gain setting in FW	Conducted TX power setting in FW		
BLE 1Mbps	CH0 (CH37)	2402 MHz	10dBm	9.95dBm	10dBm	10dBm	OdBi	10dBm		
222 21110003	CH39 (CH39)	2480 MHz	10dBm	9.88dBm	10dBm	10dBm	OdBi	10dBm		
BLE 2Mbps	CH1 (CH0)	2404 MHz	10dBm	9.94dBm	10dBm	10dBm	OdBi	10dBm		
	CH38 (CH36)	2478 MHz	10dBm	9.87dBm	10dBm	10dBm	OdBi	10dBm		
BLE	CH0 (CH37)	2402 MHz	10dBm	9.96dBm	10dBm	10dBm	OdBi	10dBm		
125kbps	CH39 (CH39)	2480 MHz	10dBm	9.88dBm	10dBm	10dBm	OdBi	10dBm		
BLE	CH0 (CH37)	2402 MHz	10dBm	9.95dBm	10dBm	10dBm	OdBi	10dBm		
500kbps	CH39 (CH39)	2480 MHz	10dBm	9.87dBm	10dBm	10dBm	OdBi	10dBm		

**NOTE1**: CERTIFIED maximum conducted RF TX power per BLE PHY. This is not what is implemented in AT firmware, this is what was certified only.

**NOTE2**: Certified Lowest common TX power setting across BLE PHY's. This lowest common TX power setting is stated since we do <u>not</u> use **per BLE** RF TX power setting in AT firmware, but same TX power setting across all 4 BLE PHY's.

**NOTE3**: IMPLEMENT in AT firmware **target** RF TX power conducted. This target actual implemented in AT firmware. So for South Korea, this is actual target 7dBm conducted. To implement that, NOTE4A defines what Antenna Gain setting MUST be used and NOTE4B defines what TX power setting MUST be used.

**NOTE4**: IMPLEMENTED in AT firmware (or MUST implement in customers own developed C-code) the Actual target RF TX power conducted:-

NOTE4A: the Antenna Gain setting of 0dBi and

NOTE4B: the TX power setting to 7dBm.

which results in:

Target Actual RF TX power (dBm) = TX power setting (dBm) - Antenna Gain setting(dBi)

7dBm = 7dBm - 0dBi

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# 13.5.8 Global (lowest common across certified countries) Radio RF TX power Table

Same as EU (CE). Refer to Europe (CE), UK (UKCA), Australia (RCM, New Zealand (RCM) Radio RF TX power Table



## 14 BLUETOOTH SIG QUALIFICATION

#### 14.1 Overview

The Lyra 24 Series module is listed on the Bluetooth SIG website as a qualified End Product, using the combination of a RF-PHY and Host Stack Components.

Design Name	Owner	Declaration ID	QDID	Link to listing on the SIG website
Lyra 24	Laird Connectivity	D063149	221359	https://launchstudio.bluetooth.com/ListingDetails/192322

#### 14.1.1 Referenced Qualified Components

Design Name	Owner	Reference QDID	Link to listing on the SIG website
EFR32BG24 and EFR32MG24RF- PHY	Silicon Laboratories	184327	https://launchstudio.bluetooth.com/ListingDetails/149435
Wireless Gecko LL and Host	Silicon Laboratories	216508	https://launchstudio.bluetooth.com/ListingDetails/187016

It is a mandatory requirement of the Bluetooth Special Interest Group (SIG) that every product implementing Bluetooth technology has a Declaration ID. Every Bluetooth design is required to go through the qualification process, even when referencing a Bluetooth Design that already has its own Declaration ID. The Qualification Process requires each company to registered as a member of the Bluetooth SIG – https://www.bluetooth.com/

The following link provides a link to the Bluetooth Registration page: https://www.bluetooth.org/login/register/

For each Bluetooth Design, it is necessary to purchase a Declaration ID. This can be done before starting the new qualification, either through invoicing or credit card payment. The fees for the Declaration ID will depend on your membership status, please refer to the following webpage:

https://www.bluetooth.com/develop-with-bluetooth/qualification-listing/qualification-listing-fees/

To purchase a new Declaration ID for your design, please follow the link below, (login is required to access this page):

Launch Studio - Manage Declaration ID (bluetooth.com)

## 14.2 Qualification Steps When Referencing on End Product Listing

For this qualification, follow these steps:

- 6. To start a listing, go to: https://www.bluetooth.org/tpg/QLI\_SDoc.cfm
- 7. Select Start the Bluetooth Qualification Process with No Required Testing.
- 8. Project Basics:
  - Enter the Project Name (this can be the product name or the Bluetooth Design name).
  - For Referenced Qualified Designs, enter QDID 221359.
- 9. Product Declaration:
  - Enter the Listing Date (this can any date ranging from the date of entry up to 90 days after submission) Your design is qualified immediately but the listing does not go public until the specified date.
- 10. Add End Product(s) Each end product that references the qualified design (without modification) can be added in this section. The Bluetooth SIG requires that you add each individual model number separately.

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#### 11. Declaration ID:

Select a Declaration ID from the list.

To complete this step, you must have already paid your Bluetooth SIG Declaration ID fee. If you have not, refer to the Bluetooth SIG Qualification Overview section for instructions. You also have the option of clicking Pay Declaration Fee accessible from this step of the Bluetooth SIG Qualification process.

- 12. Review and Submit With this, some automatic checks occur to ensure all sections are complete.
  - Review all entered information and make corrections, if needed.
  - Once you have reviewed your information, tick all of the check boxes and add your name to the signature page.

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- Click Signature Confirmed Complete Project & Submit Product(s) for Qualification. (You will be asked to confirm to proceed with the final listing one more time)
- 13. Once the listing is confirmed please download the SDoC and place a copy in the compliance folder.

For further information, please refer to the following webpage:

https://www.bluetooth.com/develop-with-bluetooth/qualification-listing/



### 15 Additional Information

Please contact your local sales representative or our support team for further assistance:

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Website www.lairdconnect.com/

Technical Support www.lairdconnect.com/resources/support

Sales Contact www.lairdconnect.com/contact

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